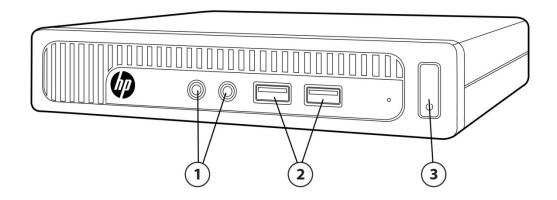
Overview

HP EliteDesk 800 G1 Desktop Mini Business PC



- 1. 3.5mm headphone output and microphone jacks
- 2. (2) Front USB 3.0 ports
- 3. Power button and PC status LED

Not Shown

Slots (1) internal M.2 connector for optional wireless NIC

(1) internal M.2 connector for optional SSD drive

Bays (1) 2.5" internal storage drive bay

Rear I/O (4) USB 3.0 ports

(1) VGA video port; (2) DisplayPort with multi-stream video ports

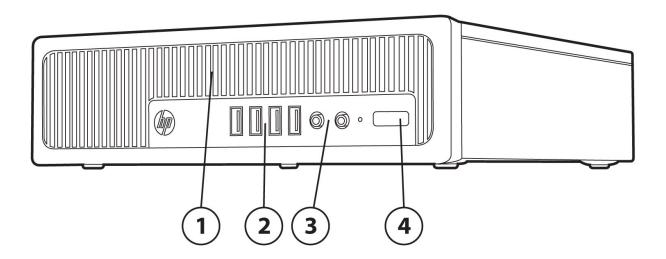
(1) RJ-45 network connector

3.5mm audio out jack

VESA Support for VESA 100 mounting system on bottom of PC chassis

HP EliteDesk 800 G1 Ultra-slim Desktop Business PC

Overview



- 1. Slim drive bay supporting an optical disk drive (located behind removable bezel)
- 2. (2) USB 3.0 ports, (2) USB 2.0 ports
- 3. 3.5mm headphone output and microphone jacks
- 4. Power button and PC status LED

Not Shown

Slots (1) internal mSATA connector

(1) internal PCI Express mini-card connector

(1) MXM graphics connector

Bays (1) 2.5" internal storage drive bay

Rear I/O (2) USB 3.0 ports; (4) USB 2.0 ports

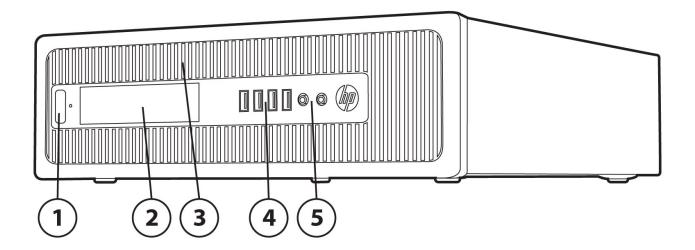
(1) VGA video port; (2) DisplayPort with multi-stream video ports

(1) RJ-45 network connector3.5mm audio in/out jacksPS/2 keyboard and mouse ports

VESA Support for VESA 100 mounting system on top and bottom of PC chassis

HP EliteDesk 800 G1 Small Form Factor Business PC

Overview



- 1. Power button and PC status LED
- 2. 3.5" external drive bay; used for installing a Media Card Reader or 2nd data storage drive
- 3. Slim drive bay supporting an optical disk drive (located behind removable bezel)
- 4. (2) USB 3.0 ports, (2) USB 2.0 ports
- 5. 3.5mm headphone output and microphone jack

Not Shown

Slots (2) PCI Express x16 graphics connectors; one wired as a x4

(2) PCI Express x1 accessory connectors

Bays (1) 2.5" internal storage drive bay

(1) 3.5" internal storage drive bay

Rear I/O (2) USB 3.0 ports; (4) USB 2.0 ports

(1) VGA video port; (2) DisplayPort with multi-stream video ports

(1) RJ-45 network connector

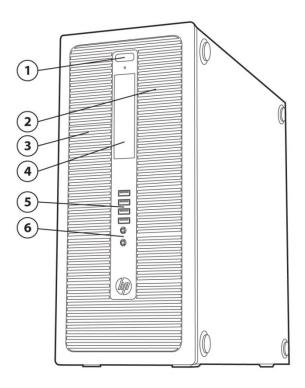
(1) RS-232 serial port

3.5mm audio in/out jacks

PS/2 keyboard and mouse ports

HP EliteDesk 800 G1 Tower Business PC

Overview



- 1. Power button and PC status LED
- 2. Slim drive bay supporting an optical disk drive (located behind removable bezel)
- 3. 5.25" half height external drive bay (located behind removable bezel)
- 4. 3.5" external drive bay; used for installing a Media Card Reader
- 5. (2) USB 3.0 ports, (2) USB 2.0 ports
- 6. 3.5mm headphone output and microphone jack

Not Shown

Slots (2) PCI Express x16 graphics connectors; one wired as a x4

(2) PCI Express x1 accessory connectors

(1) PCI accessory connector (optional)

Bays (1) 2.5" internal storage drive bay

(2) 3.5" internal storage drive bays

Rear (2) USB 3.0 ports; (4) USB 2.0 ports

I/O (1) VGA video port; (2) DisplayPort with multi-stream video ports

(1) RJ-45 network connector

(1) RS-232 serial port

3.5mm audio in/out jacks

PS/2 keyboard and mouse ports

Overview

At A Glance

- Choice of four chassis form factors: Desktop Mini, Ultra-slim Desktop, Small Form Factor and Tower
- PC chassis and all internal components and modules are manufactured with low halogen content
- HP developed and engineered UEFI BIOS supporting security, manageability and software image stability
- Intel® Q87 chipset supporting Intel 4th generation Core processors, featuring integrated Intel HD Graphics and Intel® vPro™ Technology (available with select processors)
- Intel® Ethernet Connection I217L GbE LOM integrated network connection
- DDR3 Synchronous Dynamic Random Access Memory (SDRAM)
- Multi-independent monitor support via VGA and dual digital DisplayPort video interfaces with multi-stream
- DTS Studio Sound audio management software
- · Standard and high efficiency energy saving power supply options
- SFF and TWR models can be configured with multiple data drives in a RAID array
- Optional Intel Smart Response Technology disk cache modules
- ENERGY STAR® qualified and certified EPEAT® Gold models
- · Guaranteed lengthy purchase lifecycles and image stability

Standard Features and Configurable Components

OPERATING SYSTEMS

Preinstalled When Purchased

Windows 8.1 Pro (64-bit)*

Windows 8.1 (64-bit)*

Windows 7 Ultimate (32-bit)**

Windows 7 Ultimate (64-bit)**

Windows 7 Professional (32-bit)**

Windows 7 Professional (64-bit)**

Windows 7 Professional (32-bit) (available through downgrade rights from Windows 8.1 Pro)***

Windows 7 Professional (64-bit) (available through downgrade rights from Windows 8.1 Pro)***

Windows 7 Home Premium (32-bit)**

Windows 7 Home Premium (64-bit)**

FreeDOS 2.0

Novell SUSE Linux Enterprise Desktop 11

*Not all features are available in all editions of Windows 8.1. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8.1 functionality. See http://www.microsoft.com.

**Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

***This system is preinstalled with Windows 7 Pro software and also comes with a license and media for Windows 8.1 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

CHIPSET

	<u>DM</u>	USDT	SFF/TW
Intel® Q87 Express	X	X	X

PROCESSOR

intel® 4th Generation Core 17 Processors	υM	ומכט	SFF/ I WK
Intel® Core™ i7-4765T Processor	X		
Up to 3.0 GHz Max. Turbo Frequency (2.0 GHz base frequency)			
8 MB cache, 4 cores, 8 threads			

8 MB cache, 4 cores, 8 threads

Intel HD Graphics 4600

Supports DDR3 memory up to 1600 MT/s data rate

Supports Intel® vPro[™] Technology and Intel® Stable Image Platform Program (SIPP)

Intel® Core™ i7-4770 Processor
Up to 3.9 GHz Max. Turbo Frequency (3.4 GHz base frequency)

8 MB cache, 4 cores, 8 threads

Intel HD Graphics 4600

Supports DDR3 memory up to 1600 MT/s data rate

Supports Intel® vPro[™] Technology and Intel® Stable Image Platform Program (SIPP)

X

X

QuickSpecs

Intel® Core™ i5-4670S Processor

Up to 3.8 GHz Max. Turbo Frequency (3.1 GHz base frequency)

Standard Features and Configurable Components

X Intel® Core™ i7-4770S Processor Up to 3.9 GHz Max. Turbo Frequency (3.1 GHz base frequency) 8 MB cache, 4 cores, 8 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel® vPro™ Technology and Intel® Stable Image Platform Program (SIPP) Intel Core i7-4771 Processor X Up to 3.9 GHz Max. Turbo Frequency (3.5 GHz base frequency) 8 MB cache, 4 cores, 8 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel® vPro™ Technology and Intel® Stable Image Platform Program (SIPP) Intel® 4th Generation Core™ i5 Processors DM **USDT** SFF/TWR Intel® Core™ i5-4570 Processor X Up to 3.6 GHz Max. Turbo Frequency (3.2 GHz base frequency) 6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel® vPro[™] Technology and Intel® Stable Image Platform Program (SIPP) X Intel® Core™ i5-4570S Processor Up to 3.6 GHz Max. Turbo Frequency (2.9 GHz base frequency) 6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel® vPro[™] Technology and Intel® Stable Image Platform Program (SIPP) Intel® Core™ i5-4570T Processor X Up to 3.6 GHz Max. Turbo Frequency (2.9 GHz base frequency) 4 MB cache, 4 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel® vPro[™] Technology and Intel® Stable Image Platform Program (SIPP) X Intel® Core™ i5-4670 Processor Up to 3.8 GHz Max. Turbo Frequency (3.4 GHz base frequency) 6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel® vPro[™] Technology and Intel® Stable Image Platform Program (SIPP)

Standard Features and Configurable Components

6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel® vPro™ Technology and Intel® Stable Image Platform Program (SIPP)

Intel® 4th Generation Core™ i3 Processors	DM	USDT	SFF/TWR
Intel® Core™ i3-4130 Processor 3.4 GHz base frequency 3 MB cache, 2 cores, 4 threads Intel HD Graphics 4400		х	Х
Supports DDR3 memory up to 1600 MT/s data rate			
Intel® Core™ i3-4330 Processor Up to 3.5 GHz base frequency		X	X
4 MB cache, 2 cores, 4 threads Intel HD Graphics 4600			
Supports DDR3 memory up to 1600 MT/s data rate			
Intel® Core™ i3-4340 Processor Up to 3.6 GHz base frequency		X	X
4 MB cache, 2 cores, 4 threads			
Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate			
Intel® 4th Generation Pentium™ Processors	DM	<u>USDT</u>	SFF/TWR
Intel® Pentium G3220 Processor	<u>DM</u>	<u>USDT</u> X	SFF/TWR X
Intel® Pentium G3220 Processor Up to 3.0 GHz base frequency 3 MB cache, 2 cores, 2 threads	<u>DM</u>		
Intel® Pentium G3220 Processor Up to 3.0 GHz base frequency	<u>DM</u>		
Intel® Pentium G3220 Processor Up to 3.0 GHz base frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1333 MT/s data rate Intel® Pentium G3420 Processor	<u>DM</u>		
Intel® Pentium G3220 Processor Up to 3.0 GHz base frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1333 MT/s data rate	<u>DM</u>	х	X
Intel® Pentium G3220 Processor Up to 3.0 GHz base frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1333 MT/s data rate Intel® Pentium G3420 Processor Up to 3.2 GHz base frequency	<u>DM</u>	х	X
Intel® Pentium G3220 Processor Up to 3.0 GHz base frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1333 MT/s data rate Intel® Pentium G3420 Processor Up to 3.2 GHz base frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1600 MT/s data rate Intel® Pentium™ G3420T Processor	<u>DM</u>	х	X
Intel® Pentium G3220 Processor Up to 3.0 GHz base frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1333 MT/s data rate Intel® Pentium G3420 Processor Up to 3.2 GHz base frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1600 MT/s data rate		х	X

X

QuickSpecs

320 GB 7200 rpm HDD

Standard Features and Configurable Components			
Supports DDR3 memory up to 1600 MT/s data rate			
Intel® Pentium G3430 Processor Up to 3.3 GHz base frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1600 MT/s data rate		х	х
GRAPHICS			
System Integrated Graphics	<u>DM</u>	<u>USDT</u>	SFF/TWR
Intel HD Graphics on all models (integrated on processor)	X	X	X
	<u>DM</u>	<u>USDT</u>	SFF/TWR
Optional Discrete Graphics Solutions			
AMD Radeon HD 7650A (MXM)		X	
NOTE: When this MXM graphics card is installed in the USDT all three monitor ports are active. The discrete ATI graphics will operate the top DisplayPort while the Intel integrated graphics will operate the bottom Multi-Stream DisplayPort and the VGA output.			
AMD Radeon HD 8350 (1GB) PCIe x16			X
AMD Radeon HD 8490 (1GB) PCIe x 16			X
NVIDIA NVS 310 (512 MB) PCIe x16			X
NVIDIA NVS 315 (1GB) PCIe x 16			X
NVIDIA GeForce GT630 (2 GB) FH PCIe x16			TWR only
Adapters and Cables	<u>DM</u>	<u>USDT</u>	SFF/TWR
HP DMS-59 to Dual DisplayPort Cable			X
HP DMS-59 to Dual DVI Cable			X
HP DMS-59 to Dual VGA Cable			X
HP DisplayPort to DisplayPort Cable	X	X	X
HP DisplayPort to DVI-D Adapter	X	X	X
HP DisplayPort to HDMI Adapter	X	X	X
HP DisplayPort to VGA Adapter	X	X	X
HP Serial Port Adapter			X
HP Parallel Port Adapter			X
STORAGE			
Hard Disk Drives (HDD)	DM	USDT	SFF/TWR

Standard Features and Configurable Components				
500 GB 7200 rpm HDD		X	X	X
500 GB 7200 rpm SED HDD		X	X	X
500 GB 10K rpm HDD				X
1 TB 7200 rpm HDD				X
1 TB 10K rpm HDD				X
2 TB 7200 rpm HDD				X
Solid State Hybrid Drives (SSHD)		<u>DM</u>	<u>USDT</u>	SFF/TWR
500 GB SSHD (8 GB cache)		X	X	X
1 TB SSHD (8 GB cache)		X	X	X
Solid State Drives (SSD) & Self-encrypting Solid State Drives (SED)		<u>DM</u>	<u>USDT</u>	SFF/TWR
120 GB Opal SED		X	X	X
128 GB SSD			X	X
128 GB Opal SED		X	X	X
160 GB SSD			X	X
180 GB Opal SED		X	X	X
256 GB SED			X	X
128 GB M.2 PCle SSD		X		
256 GB Opal SED		Х	X	X
Optical Disc Drives		<u>DM</u>	USDT	SFF/TWR
Slim DVD-ROM			X	X
Slim BDXL Blu-ray Writer			X	X
Slim SuperMulti DVD Writer			X	X
HH Supermulti ODD				TWR only
Removable				
HP Slim Removable SATA HDD Frame/Carrier			X	X
MEMORY				
Form Factor	Туре	Maximum	#	of Slots
Desktop Mini	DDR3 non-ECC Up to 1600 MT/s	16 GB	2	SODIMM
Ultra-slim Desktop	DDR3 non-ECC Up to 1600 MT/s	16 GB	2	SODIMM
Small Form Factor	DDR3 non-ECC Up to 1600 MT/s	32 GB		4 DIMM
Tower	DDR3 non-ECC Up to 1600 MT/s	32 GB		4 DIMM

Standard Features and Configurable Components

NOTE: For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.

Memory modules support data transfer rates up to 1600 MT/s; actual data rate is determined by the system's configured processor. See processor specifications for supported memory data rate.

PERFORMANCE

Intel® Smart Response Technology Disk Cache Modules	<u>DM</u>	<u>USDT</u>	SFF/TWR
32GB 2.5" Solid State Disk Cache			X
32GB mSATA Solid State Disk Cache		X	
NETWORKING/COMMUNICATIONS			
Ethernet (RJ-45)	DM	<u>USDT</u>	SFF/TWR
Intel I217LM Gigabit Network Connection (standard)	X	X	X
Intel Ethernet I210-T1 PCIe x1 Gb Network Interface Card (optional)			X
Wireless			
Intel Centrino Advanced-N 6205 802.11 a/b/g/n PCI Express x1 Wireless Network Connection (optional)			X
Intel Centrino Advanced-N 6205 802.11 a/b/g/n PCI Express Mini Card Wireless Network Connection (optional)		X	
Intel Wireless-N 7260 802.11 M.2 a/b/g/n NIC Card Wireless Network Connection	Х		
Intel Wireless-N 7260 802.11 a/b/g/n Mini PCIe NIC Card (USDT Only) Wireless Network Connection (optional)			
Intel Wireless-N 7260 802.11 a/b/g/n PCle- Clink Card (SFF/TWR Only) Wireless Network Connection (optional)			

NOTE: Either the integrated network connection or the Intel Centrino wireless NIC is required to support Intel vPro Technology features.

Audio/Multimedia	<u>DM</u>	USDT	SFF/TWR
HD audio with Realtek ALC221 codec (all ports are stereo)	X	X	X
DTS Studio Sound audio management technology	X	X	X
Microphone* and headphone front ports (3.5mm)	X	X	X
Line-out and Line-In rear Ports* (3.5mm)	Line out only	X	X
Multi-streaming capable*	X	X	X

Standard Features and Configurable Components

Internal speaker (standard)

 \mathbf{X} \mathbf{X} \mathbf{X}

KEYBOARDS AND POINTING DEVICES

Keyboard	DM	<u>USDT</u>	SFF/TWR
HP PS/2 Keyboard	X	X	X
HP USB Keyboard	X	X	X
USB Smart Card (CCID) Keyboard	X	X	X
HP USB and PS/2 Washable Keyboard	X	X	X
HP Wireless Keyboard and Mouse Combo*	X	X	X

^{*}Keyboard contains 25% post-consumer recycled plastic material.

Mice	DM	<u>USDT</u>	SFF/TWR
HP PS/2 Mouse	X	X	X
HP USB Mouse	X	X	X
HP USB 1000dpi Laser Mouse	X	X	X
HP USB and PS/2 Washable Mouse	X	X	X

HP BIOS

Key features of the HP BIOS include:

- Deployment and manageability HP BIOS provides several technologies that help integrate the HP EliteDesk 800 G1
 Business PC into the enterprise, such as PXE, remote configuration, remote control, and F10 Setup support for 12
 languages.
- Select models feature either Intel Standard Manageability or Intel Core vPro Processor Technology.
- Stability HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- UEFI specification 2.1
- Computrace agent For tracking and tracing services, available in select countries, separate software and purchase
 of a subscription is required.
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies so component temperatures are managed for high reliability and to assist in operating the HP Business Desktop computer in any enterprise environment.
- Acoustic performance Industry leading acoustic emissions across the range of operating conditions.
- Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade HP Business Desktop computers, including BIOS updates from within DOS (DOSFlash), BIOS updates from within Windows (HPQFlash), HP Client Manager, and fail-safe recovery. In addition, the HP Business Desktop BIOS Utilities tool enables replicated BIOS setup throughout

^{*} The front microphone port is re-taskable as a Line-in, Microphone-in or Headphone-out port. Rear audio input ports are retaskable as a Line-in or Microphone-in port. External speakers must be powered externally. Multi-streaming can be enabled in the Realtek control panel to allow independent audio streams to be sent to/from the front and rear jacks. This allows for different audio applications to use separate audio ports on the system. For example, the front jacks could be used with a headset for a communications application while the rear jacks are being used with external speakers and a multimedia application.

Standard Features and Configurable Components

the Enterprise; it is available from within the BIOS software and from the support website.

HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.

Additional HP BIOS Features

- Power-On password Helps prevent an unauthorized user from powering on the system.
- Administrator password Also known as the setup password, this helps prevent unauthorized changes to the
 system configuration. If the administrator password is not known, the BIOS version cannot be changed and changes
 cannot be made to BIOS settings using F10 setup or under the OS.
- Advanced Configuration and Power Interface (ACPI) Represents a significant innovation in power and configuration
 management, allowing operating systems and applications to manage power based on activity and usage. HP Elite
 models use ACPI to provide power conservation features.

S5 Max Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 1W is S5 (when turned off). When S5 Max Power Savings feature is enabled power to slots is turned off along with WOL functionality.

SECURITY

	USDT/DM	SFF/TWR
Trusted Platform Module (TPM) 1.2	X	X
SATA port disablement (via BIOS)	X	X
Drive lock	X	X
RAID configurations		X
Intel® Identify Protection Technology (IPT) ¹	X	X
Serial, parallel, USB enable/disable (via BIOS)	X	X
Optional USB Port Disable at factory (user configurable via BIOS)	X	X
Removable media write/boot control	X	X
Power-On password (via BIOS)	X	X
Setup password (via BIOS)	X	X
HP Chassis (1 bay) Security Kit		TWR only
Solenoid Hood Lock / Sensor	USDT only	X
Support for chassis padlocks and cable lock devices	X	X

¹Models configured with Intel Core processors have the ability to utilize advanced security protection for online transactions. IPT, used in conjunction with participating web sites, provides double identity authentication by adding a hardware component in addition to the usual user name and password. IPT is initialized through an HP Client Security module

ENVIRONMENTAL & REGULATORY

ENERGY STAR® qualified models available

EPEAT® registered where applicable/supported. See www.epeat.net for registration status by country.

Low halogen (chassis, all internal components and modules)

TAA compliant

PORTS

Standard Features and Configurable Components

1/0) Po	rts -	- Sta	nda	rd

	<u>DM</u>	<u>usdt</u>	SFF/TWR
USB 2.0	N/A	2 (front); 4 (rear)	2 (front); 4 (rear)
USB 3.0	2 (front); 4 (rear)	2 (front); 2 (rear)	2 (front); 2 (rear)
Serial (RS-232)	N/A	N/A	1
PS/2	N/A	1 keyboard (purple) 1 mouse (green)	1 keyboard (purple) 1 mouse (green)
Video	1 ea. VGA 2 ea. DisplayPort with multi-stream	1 ea. VGA 2 ea. DisplayPort with multi-stream	1 ea. VGA 2 ea. DisplayPort with multi-stream

NOTE: When configured with an Intel Celeron, Pentium or 4th generation Intel Core i3 CPU only two of the available video output ports are active

Audio	Front: headphone/mic Rear: line in/out	Front: headphone/mic Rear: line in/out	Front: headphone/mic Rear: line in/out
	3.5mm diameter	3.5mm diameter	3.5mm diameter
Network Interface	RJ-45	RJ-45	RJ-45

I/O Ports - Optional

	<u>DM</u>	<u>USDT</u>	SFF/TWR
2nd Serial (RS-232)	N/A	N/A	1
Parallel	N/A	N/A	1

SLOTS				
	<u>DM</u>	<u>USDT</u>	<u>SFF</u>	TWR
PCI Express Mini Card	N/A	1	N/A	N/A
MXM Graphics	N/A	1	N/A	N/A
mSATA	N/A	1	N/A	N/A
M.2	1 ea. M.2-2230 (for WLAN) 1 ea. M.2-2280 (for storage)	N/A	N/A	N/A
PCI Express x1 (v2.0)	N/A	N/A	2 ea. 2.5" low profile 6.6" length 10W max. power	2 ea. 4.2" full height 6.6" length 10W max. power
PCI Express x16 (v2.0) (wired as a x4)	N/A	N/A	1 ea. 2.5" low profile 6.6" length 35W max. power	1 ea. 4.2" full height 6.6" length 35W max. power
PCI Express x16 (v3.0)	N/A	N/A	1 ea. 2.5" low profile 6.6" length 35W max. power	1 ea. 4.2" full height 6.6" length 75W max. power
Optional PCI (v2.3)	N/A	N/A	N/A	1 ea. 4.2" full height 6.6" length

Standard Features and Configurable Components

NOTE: The TWR can support a single graphics card up to 75W. When configured with dual graphics cards support is limited to 35W for each.

BAYS

	<u>DM</u>	<u>USDT</u>	<u>SFF</u>	<u>TWR</u>
3.5" Media Card Reader	N/A	N/A	1 ea.	1 ea.
5.25" Half Height ODD	N/A	N/A	N/A	1 ea.
Slim ODD	N/A	1 ea.	1 ea.	1 ea.
Secure Digital (SD) Reader	N/A	1 ea.	N/A	N/A
2.5" internal storage drive	1 ea.	1 ea.	1 ea.	1 ea.
3.5" internal storage drive	N/A	N/A	1 ea.	2 ea.

SERVICE AND SUPPORT

On-site Warranty 1: Three-year (3-3-3) limited warranty delivers three years of on-site, next business day 2 service for parts and labor and includes free telephone support 3 24 x 7. Three-year onsite and labor are not available in all countries. Service offers terms up to 5 years by choosing a Care Pack. To choose the right level of service for your HP product, visit HP Care Pack Central: www.hp.com/go/cpc

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.

NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

NOTE 3: Technical telephone support applies only to HP-configured and third-party HP qualified hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.

OPERATING SYSTEMS

Preinstalled Windows 8.1 Pro (64-bit)*

Windows 8 .1 (64-bit)*

Windows 7 Ultimate (32-bit)**
Windows 7 Ultimate (64-bit)**
Windows 7 Professional (32-bit)**
Windows 7 Professional (64-bit)**

Windows 7 Professional (32-bit) (available through downgrade rights from Windows 8.1 Pro)*** Windows 7 Professional (64-bit) (available through downgrade rights from Windows 8.1 Pro)***

Windows 7 Home Premium (32-bit)**
Windows 7 Home Premium (64-bit)**

FreeDOS 2.0

Novell SUSE Linux Enterprise Desktop 11

For all Preinstalled operating systems HP provides Microsoft WHQL certified (where applicable) drivers on www.hp.com at the time of product announcement.

Web Support Windows 7 Enterprise (32-bit or 64-bit)

Windows 8 (64-bit)
Windows 8 Pro (64-bit)*

Windows 8 Enterprise (64-bit)**

Standard Features and Configurable Components

For all Supported operating systems HP performs testing of the OS, and makes available all HP value add software (OS dependent). Certified drivers are made available on www.hp.com within 30 days of product announcement.

Certified Novell SUSE Linux Enterprise Desktop 11¹

Red Hat Enterprise Linux 64¹

For all Certified operating systems HP will submit hardware to the operating system vendor for testing and certification. All drivers would be obtained from the operating system vendor, not supplied by HP. Certification will be posted by the operating system vendor.

Test & Document Windows® Vista Enterprise (32-bit or 64-bit)

Windows® Vista Professional (32-bit or 64-bit)

For all Test & Document operating systems HP will perform functional testing of the operating system on the HP business PC platform. Any issues found will be documented in an Engineering Advisory and/or Service Advisory and posted to www.hp.com. HP will not develop or qualify any drivers or perform any integration testing.

*Not all features are available in all editions of Windows 8.1. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8.1 functionality. See http://www.microsoft.com.

**Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

***This system is preinstalled with Windows® 7 Pro software and also comes with a license and media for Windows 8.1 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

¹The following features are not supported by Novell SUSE Linux Enterprise Desktop:

- Intel Gigabit CT Desktop NIC
- Broadcom NetXtreme Gigabit Ethernet Plus
- HP Media Card Reader
- HP Client Security
- HP Blu-ray Writer playback of commercial movies
- · DisplayPort video interface
- HP 2nd serial port adapter
- Power Management features

Systems configured with Linux do not qualify for ENERGY STAR®

The following features are not supported by Red Hat Enterprise Linux 64:

- TPM v1.2 embedded Security Chip
- Intel Gigabit CT Desktop NIC
- HP Wireless 802.11b/g/n NIC
- HP Media Card Reader
- HP Blu-ray Writer
- HP 2nd serial port Adapter
- HP USB Smart Card (CCID) Keyboard

Standard Features and Configurable Components

Power Management features

Systems configured with Linux do not qualify for ENERGY STAR®

SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

Included	Windows 7	Windows 8.1
Security	Computrace (status tracing) ¹ Device Access Manager Drive Encryption ⁴ File Sanitizer (Activated via Wizard) Disk Sanitizer (external version) ² Microsoft Security Essentials HP Client Security	Computrace (status tracing) ¹ Device Access Manager Drive Encryption ⁴ File Sanitizer (Activated via Wizard) Disk Sanitizer (external version) ² Microsoft Defender Secure Erase HP Client Security
MultiMedia	Cyberlink Power DVD, BD Cyberlink Power2Go (Secure Burn)	Cyberlink Power DVD, BD Cyberlink Power2Go (Secure Burn)
Communication		HP Wireless Hotspot
HP Value Add	HP ePrint Driver ³ HP PageLift HP Support Assistant HP Recovery Disk Creator	HP ePrint Driver ³ HP PageLift HP Recovery Manager HP Support Assistant HP QuickStart
3 rd Party	Adobe Flash Player Bing Search for Internet Explorer 10 Box PDF Complete, Corporate Edition Skype	Bing Search PDF Complete, Corporate Edition Skype
Microsoft Products	Buy Office	Buy Office

¹ Computrace agent is shipped turned off, and must be activated by customers when they purchase a subscription. Subscriptions can be purchased for terms ranging from one to five years. Service is limited, check with Absolute for availability outside the U.S.

² Available via download

³ Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see www.hp.com/go/eprintcenter). Requires optional broadband module. Broadband use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary

⁴ Drive Encryption is planned to be available in October 2013. Requires Windows. Data is protected prior to Drive Encryption login. Turning the PC off or into hibernate logs out of Drive Encryption and prevents data access.

Technical Specifications – Core vPro Processors

INTEL 4th GENERATION CORE vPRO PROCESSORS

All HP EliteDesk 800 G1 Business PC models featuring this technology include processors that are part of the Intel 2013 Stable Image Platform Program (SIPP) designed to ensure the stability promise inherent in the value proposition of the HP EliteDesk 800 G1 Business PC, thus making these models the most stable, secure, and manageable platforms available to enterprises today.

Intel® Advanced Management Technology (AMT) v9.0 – An advanced set of remote management features and functionality which provides network administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 9.0 includes the following advanced management functions:

- Power Management (on, off, reset)
- Hardware Inventory (includes BIOS and firmware revisions
- Hardware Alerting
- · Agent Presence
- System Defense Filters
- SOL/IDER
- Cisco NAC/SDN Support
- ME Wake-on-LAN
- DASH 1.1 compliance
- IPv6 Support
- Fast Call for Help a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection
- Remote Scheduled Maintenance pre-schedule when the PC connects to the IT or service provider console for maintenance. Remote PCs can get required patches, be inventoried, etc by connecting to their IT console or Service Provider when it's convenient.
- Remote Alerts automatically alert IT or service provider if issues arise
- Access Monitor Provides oversight into Intel® AMT actions to support security requirements
- PC Alarm Clock
- Microsoft NAP Support
- Host Base set-up and configuration
- Management Engine (ME) firmware roll back
- Wireless AMT functionality on Desktop (WoDT)
- Enhanced KVM resolution

Technical Specifications - Graphics

VGA Controller	Integrated			
		Port Audio (2 strooms) UPD2 link rates and		
DisplayPort	Multimode capable; supports HDCP, Display F Multi-Stream Technology for a maximum of 3			
Bus Type	N/A			
RAMDAC	N/A			
Memory	Intel graphics do not have dedicated memory system memory The amount of memory used system memory installed, BIOS settings, ope pre-allocated for graphics use at system boo at boot time by the BIOS for PAVP (Protected playback of protected video content. Additional memory is allocated for graphics at Memory Technology (DVMT), to provide an ope system memory use.	d for graphics depending on the amount of rating system, and system load. 32 MB is It time. Additional memory can be allocated Audio Video Playback) support for as needed using Intel's Dynamic Video		
	Microsoft Windows 7	Windows 8.1		
Maximum Graphics Memory	Up to 1.7GB	Up to 1.8GB		
	Note: the actual amount of maximum graphics memory can be less than the amounts listed above depending upon your computer's configuration.			
Maximum Color Depth	32 bits/pixel			
Graphics/Video API Support	core enabling substantial gains in per Up to 16 EU support. Next Generation Intel Clear Video Te video playback and enhancement fe experience Encode/transcode HD conte Playback of high definition Superior image quality with	content including Blu-ray Disc o sharper, more colorful images upport for accelerating video processing ecode		

Technical Specifications - Graphics

Resolution	Refresh Rates
800x600	60 Hz
1024x768	60 Hz
1152x864	60 Hz
1280x600	60 Hz
1280x720	60 Hz
1280x800	60 Hz
1280x960	60 Hz
1280x1024	60 Hz
1360x768	60 Hz
1366x768	60 Hz
1400x1050	60 Hz
1440x900	60 Hz
1600x900	60 Hz
1600x1200*	60 Hz
1680x1050	60 Hz
1920x1080	60 Hz
1920x1200*	60 Hz
1920x1440*	60 Hz
2560x1440*	60 Hz
2560x1600*	60 Hz
* Only supported on displays connected to the external DisplayPort connector.	

AMD Radeon HD 7650A Graphics Card		
Form Factor	MXM 3.0	
Graphics Controller	AMD Radeon HD 7650A	
Core Clock	600MHz	
Memory Clock	800MHz	
Memory	2GB, DDR3, 128-bit wide	
Bus Type	мхм	
Max. Power	35W	
Power Source Support	12V and 19V	
3D API Support	DX11, SMS	
HDCP Support	Yes	

Technical Specifications - Graphics

Display Max. Resolution	Digital 2560 x 1600 Analog 2048 x 1536
Supported Graphics APIs	DX11, OpenGL, full 1080p BD (H264) playback in hardware, Multi-Stream DisplayPort support

Supported Display Resolutions and Refresh Rates

Note: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Refresh Rates
60 Hz

NVIDIA NVS 310 Graphics Card

card targeted as an active low cost graphics solution for the corporate business and enterprise markets. The NVIDIA® NVS 310 graphics card is an ideal solution for customers requiring a small f factor graphics add-in card for either standard or small form factor PC designs. Performance and Features The NVIDIA® NVS 310 Graphics Card offers 512 MB of ultrafast DDR3 memory and is cap of supporting up to 2 displays. DisplayPort connector supports multimode technology to support connection to DVI-D,	<u> </u>	
of supporting up to 2 displays. DisplayPort connector supports multimode technology to support connection to DVI-D, and HDMI monitors with optional adapters in kits NR078AA, FH973AT, BP937AA, AS615. For a DisplayPort to DisplayPort connections use the optional DisplayPort Cable Kit VN567AA. Form Factor Low Profile: 2.713 × 6.15 in NVIDIA® NVS 310	Introduction	enterprise markets. The NVIDIA® NVS 310 graphics card is an ideal solution for customers requiring a small form
Graphics Controller NVIDIA® NVS 310	Performance and Features	DisplayPort connector supports multimode technology to support connection to DVI-D, VGA and HDMI monitors with optional adapters in kits NR078AA, FH973AT, BP937AA, AS615AA. For a DisplayPort to DisplayPort connections use the optional DisplayPort Cable Kit
	Form Factor	Low Profile: 2.713 × 6.15 in
Memory Clock 875MHz	Graphics Controller	NVIDIA® NVS 310
	Memory Clock	875MHz

Technical Specifications - Graphics

Memory Size	512 MB DDR3	
Memory Bandwidth	14 GB/s	
Max. Power	19.5W	
Display Max. Resolution	Up to 2560 x 1600 (digit	tal display) per display
Display Output	Up to 2 displays in the following configurations	
	DisplayPort output:	 Drives two DisplayPort enabled digital display at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors on the NVS 310 graphics card Supports 2 monitors up to resolution of 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort Multi-Stream topology technology.
	DVI-D output:	 Drives two digital display at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors Drives two digital display at resolutions up to 2560× 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors
	HDMI output:	 NVS 310 is capable of driving two high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors
	VGA display output:	Drives two analog display at resolutions up to 1920 × 1200 at 60 Hz using DisplayPort to VGA cable adaptors

Supported Display Resolutions and Refresh Rates

Resolution		Maximum Refresh Rat	tes (Hz) by Connection	
	DisplayPort to VGA	DisplayPort to DVI-D	DisplayPort to HDMI	DisplayPort
640 x 480	85	60	60	60
800 x 600	85	60	60	60
1024 x 768	85	60	60	60
1280 x 720	85	60	60	60
1280 x 1024	85	60	60	60
1440 x 900	75	60	60	60
1600 x 1200	60	60	60	60
1680 x 1050	60	60	60	60
1920 x 1080	60-R	60-R	60	60

Technical Specifications - Graphics

1920 x 1200	60-R	60-R	60
1920 x 1440			60
2048 x 1536			60
2560 x 1600			60

NVIDIA GeForce GT630	Graphics Card
Introduction	The NVIDIA GeForce GT630 DP (2GB) PCIe x16 Card Graphics Card provides a full height, PCI Express x16 graphics add-in card solution based on the NVIDIA Kepler Architecture GPU. The card is designed to support three display connections through its DVII, and two DisplayPort connectors.
	An ideal solution for desktop PC customers seeking enhanced 2D and advanced 3D graphics performance, the NVIDIA GeForce GT630 DP (2GB) PCIe x16 Cards are an excellent choice for business users who want run multiple displays from a single graphics board. Engage in Web conferencing or video or photo editing, while improving your everyday business PC experience with better graphics and excellent visual display quality.
Performance and Features	The NVIDIA GeForce GT630 DP (2GB) PCIe x16 Cards deliver superior PCI Express (PCIe) Gen 3 features including:
	 Unprecedented flexibility for new applications and enhanced performance Support for NVIDIA surround technology Run multiple displays from a single graphics card Full 16 lane PCIe Generation 3 bus support with peak bandwidth support Wireless Display ready for future support
Form Factor	PCIe x16 Card
Graphics Controller	NVIDIA Kepler Architecture GPU
Core Clock	875 MHz
Memory Clock	891 MHz
Memory Size	2 GB DDR3 128 bit
Memory Bandwidth	28.5 GB/s
Display Max. Resolution	2560 x 1600 digital, 2048 x 1536 analog
Display Support	Integrated 400 MHz RAMDAC

Technical Specifications - Graphics

Supported Display Resolutions and Refresh Rates

Resolution	Maximum Refresh Rates (Hz)	
	Analog Connection	Digital Connection
640 x 480	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 1024	85	60
1440 x 900	75	60
1600 x 1200	85	60
1680 x 1050	75	60
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	60
2048 x 1536	75	60
2560 x 1600	N/A	60

NVIDIA NVS 315 1GB PCI	e x 16 Graphics Card
Introduction	Get efficient dual-display graphics performance in a PCI Express low-profile graphics card with the NVIDIA NVS 315 PCIe x16 1 GB Graphics Card, an ideal desktop graphics solution for professional business and commercial applications.
Performance and Features	The NVIDIA® NVS 315 Graphics Card offers 1 GB of ultrafast DDR3 memory and is capable of supporting up to 2 displays.
	DisplayPort connector supports multimode technology to support connection to DVI-D, VGA and HDMI monitors with optional adapters in kits NR078AA, FH973AT, BP937AA, AS615AA.
	For a DisplayPort to DisplayPort connections use the optional DisplayPort Cable Kit VN567AA.
Form Factor	Low Profile: 2.713 × 6.15 in
Graphics Controller	NVIDIA® NVS 315
Memory Clock	875MHz
Memory Size	512 MB DDR3
Memory Bandwidth	14 GB/s

Technical Specifications - Graphics

Connectors	DMS-59, with support for dual VGA, dual DVI or dual Display Port with the appropriate adapter cable
Display Max. Resolution	Up to 2048 x 1536 VGA; 1920 x 1200 DVI; 2560 x 1600 DisplayPort
Display Output	Up to 2 displays in the following configurations
	Dual DVI:

Supported Display Resolutions and Refresh Rates

Resolution	Maximum Refresh Ra	ates (Hz) by Connection
	Analog Connection	Digital Connection
640 x 480	85	60
720 x 480	85	60
720 x 576	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 768	85	60
1280 x 1024	85	60
1440 x 900	75	60
1600 x 1024	85	60
1600 x 1200	85	60
1680 x 1050	75	60
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A
2560 x 1440	N/A	60*
2560 x 1600	N/A	60*
		* Display Port Only

Technical Specifications - Graphics

AMD Radeon HD 8350 1	1GB PCie x16 DH Graphics Card
Introduction	Get stable 2D and advanced 3D graphics performance from the AMD Radeon HD 8350 1 GB PCIe x16 DH Graphics Card, a low profile, PCI Express x16 graphics add-in card based on the AMD Radeon HD 8350 GPU, great for Web conferencing or video and photo editing.
Form Factor	PCie x16
Graphics Controller	AMD Radeon HD 8350
Core Clock	GPU engine operates at 523 MHz
Memory	1GB, DDR3, SDRAM
Memory Clock	875 MHz
HDCP Support	Yes
Display Max. Resolution	Digital 1920 x 1200 Analog 2048 x 1536

Supported Display Resolutions and Refresh Rates

	Analog Connection	Digital Connection
640 x 480	85	60
720 x 480	85	60
720 x 576	85	60
300 x 600	85	60
024 x 768	85	60
280 x 720	85	60
280 x 768	85	60
280 x 1024	85	60
140 x 900	75	75
500 x 1024	85	60
500 x 1200	85	60
580 x 1050	75	75-R
920 x 1080	85	60-R
920 x 1200	85	60-R
920 x 1440	85	N/A
048 x 1536	75	N/A
560 x 1440	N/A	N/A

Technical Specifications - Graphics

2560 x 1600 N/A	N/A
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AMD Radeon HD 8490	1GB PCie x16 Graphics Card
Introduction	Get impressive graphics and high resolution dual-display performance in a low profile, PCI Express x16 graphics add-in card based on the AMD Radeon HD 8490 Graphics Processor. Improve your everyday PC, Web conferencing, and video or photo editing.
Form Factor	PCie x16
Graphics Controller	AMD Radeon HD 8490
Core Clock	GPU engine operates at 875 MHz
Memory	1GB, DDR3, SDRAM
Memory Clock	900 MHz
HDCP Support	Yes
Display Max. Resolution	Digital 2560 x 1600 Analog 2048 x 1536

Supported Display Resolutions and Refresh Rates

	Analog Connection	Digital Connection
300 x 200	85	60
320 x 240	85	60
400 x 300	85	60
640 x 480	85	60
720 x 480	85	60
720 x 576	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 768	85	60
280 x 1024	85	60
1440 x 900	75	75
1600 x 900	85	60
1600 x 1024	85	60

Technical Specifications - Graphics

1600 x 1200	85	60
1680 x 1050	75	75-R
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A
2560 x 1440	N/A	60
2560 x 1600	N/A	60

Technical Specifications – Hard Disk and Solid State Storage

Introduction:

HP Serial Advanced Technology Attachment (SATA) Hard Drives maximize the performance of HP Business PCs by providing the technologies to meet your increasing storage demands with high-capacity drives offering superior reliability and performance.

SATA provides faster data transfer speeds, better system cooling airflow, more bandwidth, more headroom for speed increases in future generations and better data integrity. A next-generation technology, the SATA interface connects hard drives to the PC platform enabling easy aggregation of multiple hard drives into a single PC. This offers you the additional benefits of dedicated bandwidth, the ability to more easily identify device failures and scalability. The HP EliteDesk 800 G1 Series Business PC supports the latest SATA 6.0Gb/s specification.

HP Drive Lock

HP Serial ATA Hard Drives offer enhanced security via a new Drive Lock. When enabled, this ATA security feature set prevents software access to user data on the drive until one or two user-defined passwords are provided.

SMART IV Technology

Self-Monitoring Analysis and Reporting Technology (SMART) hard drive technology allows hard drives to monitor their own health and to raise flags if imminent failures are predicted. If the drive determines that a failure is imminent, the SMART hard drive technology enables the intelligent manageability or management software to generate a fault alert. While the current versions of SMART hard drives do a good job monitoring the data on the hard drive media, the ever increasing emphasis on reliability and quality has promoted HP to implement SMART IV technology which constantly checks that the data flow from host interface to media and media to host interface is not compromised. This is accomplished by inserting a 2 byte parity code into every 512 byte block in the data path of the hard drive's Cache RAM. This unique parity checking performed by HP's SMART IV technology hard drives, allows for more complete error detection coverage encompassing the entire data path between the host and the hard drive.

Smart IV is also known as IOEDC: I/O Error Detection Code.

Native Command Queuing

NCQ or Native Command Queuing is a SATA protocol extension that allows the hard drive to have several write or read commands outstanding at the same time. In contrast, normal non-queued operation requires each command to be completed before the next command is issued by the host system. Queuing allows the drive to complete the commands in the order that allows for best overall throughput. It also involves an advanced method of transferring data to or from the host, called First Party Direct Memory Access (FPDMA), which allows the hard drive and the host controller to manage the data transfers for multiple outstanding commands, without involving the host processor. NCQ can contribute to better performance but the results are dependent on many factors, including the access patterns of the various applications and operating system functions that are initiating drive accesses. Enabling NCQ features in the hard drive requires AHCI support from the host system BIOS, controller, and driver. AHCI support is typically implemented in RAID configurations.

Note: GB = 1 billion bytes. Actual available capacity is less.

Redundant Array of Independent Drives (RAID)

Flexible implementation:

Technical Specifications – Hard Disk and Solid State Storage

- DriveLock is supported while in RAID mode. Users can manage the DriveLock password from within F10 Setup. Locked drives will be displayed as such in the RAID option ROM interface.
- Hard drive information can be viewed within F10 Setup while in RAID mode. Previously, the hard drives will not appear in Drive Configuration when switching to RAID mode.
- DPS Self-Test can be executed on physical hard drives while in RAID mode.
- The RAID Setup Utility (accessed through CTRL-I) can be protected by the F10 Setup password.

NOTE:

RAID 1 is the only RAID configuration offered via factory configurations. The pre-configured systems:

- Are only available on the SFF and TWR form factors. The USDT and DM form factors do not support RAID as they do not allow for multiple common storage drives.
- Are complete RAID systems and have both drives installed. If the TWR is configured with three hard disk drives, the third drive is would be un-partitioned and not part of the RAID array
- Have the necessary Option ROM configuration.
- Are pre-loaded and pre-installed with all required Intel software.
- Include a preinstalled operating system that is mirrored mode out of the box.

HP 1TB 10K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive			
Unformatted Capacity	1 TB		
Rotational Speed	10,000 rpm		
Interface	Serial ATA (6.0 Gb/s)		
Synchronous Transfer Rate (Maximum)	Up to 600 MB/s	Up to 600 MB/s	
Buffer Size	64 MB	64 MB	
Cache	Adaptive		
Sack Time (tupical roads	Single Track:	1.2 ms	
Seek Time (typical reads, includes controller overhead,	Average:	3.6 ms	
including settling)	Full-Stroke:	9.0 ms	
Height (nominal)	0.6 in/1.53 mm	0.6 in/1.53 mm	
Middle (nominal)	Media diameter: 2.5 in/63.6 mm		
Width (nominal)	Physical size: 2.75 in/69.9 mm		
Operating Temperature	41° to 131° F (5° to 55° C)		

HP 500 GB 10K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive			
Unformatted Capacity	500 GB	500 GB	
Rotational Speed	10,000 rpm		
Interface	Serial ATA (6.0 Gb/s)		
Synchronous Transfer Rate (Maximum)	Up to 600 MB/s	Up to 600 MB/s	
Buffer Size	64 MB		
Cache	Adaptive		
Seek Time (typical reads,	Single Track:	1.2 ms	
includes controller overhead, including settling)	Average:	3.6 ms	
including Settling)	Full-Stroke:	9.0 ms	
Height (nominal)	0.6 in/1.53 mm	0.6 in/1.53 mm	
Width (nominal)	Media diameter: 2.5 in/63.6 mm		
wiuth (nominal)	Physical size: 2.75 in/69.9 mm		
Operating Temperature	41° to 131° F (5° to 55° C)		

HP 320-GB 7.2K SATA 6.0Gb/s 2.5" Hard Disk Drive		
Capacity	320,072,933,376 bytes	
Rotational Speed	7,200 rpm	
Interface	Serial ATA 2.0 (6.0 Gb/s)	
Buffer Size	16 MB	
Logical Blocks	488,397,168	
Seek Time (typical reads, includes controller overhead,	Single Track:	2.0 ms
	Average:	12 ms

Technical Specifications – Hard Disk and Solid State Storage

including settling)	Full-Stroke:	22 ms
Height (nominal)	0.374 in/9.5 mm	
half-date (or assistant)	Media diameter: 2.5 in/63.5 mm	
Width (nominal)	Physical size: 2.75 in/70 mm	
Operating Temperature	41° to 131° F (5° to 55° C)	

HP 500-GB 7200 RPM SATA 2.5" Self-Encrypting (SED) Hard Disk Drive		
Capacity	500,107,862,016 bytes	
Rotational Speed	7,200 rpm	
Drive Type	Self-Encrypting Drive (S	ED) with SATA interface
Interface	SATA Interface conform	ing to Serial ATA International Organization: Serial ATA Revision 2.6
Segmented Buffer with write cache	32768 KB - A portion of buffer capacity used for firmware	
Number of Sectors	976,773,168	
	Single Track:	1.0 ms
Seek Time (typical reads)	Average:	13 ms
	Full-Stroke:	25 ms
Media Diameter	2.5 in/63.5 mm	
Height	0.267 in/6.8 mm, ±0.2mm	
Width	2.75 in/69.85 mm, ±0.25mm	
Length	3.945 in/100.2 mm, ±0.25mm	
Weight	3.35 oz/95 g (max)	
Operating Temperature	32° to 140° F (0° to 60° C)	

HP 500-GB 7.2K SATA 6.0Gb/s 2.5" Hard Disk Drive

Capacity	500,107,862,016 bytes	
Rotational Speed	7,200 rpm	
Interface	Serial ATA 2.0 (6.0 Gb/s	
Buffer Size	16 MB	
Logical Blocks	976,773,168	
Seek Time (typical reads,	Single Track:	2.0 ms
includes controller overhead, including settling)	Average:	12 ms
including setting)	Full-Stroke:	25 ms
Height (nominal)	0.374 in/9.5 mm	
Width (nominal)	Media diameter: 2.5 in/63.5 mm	
with (HOHIIId)	Physical size: 2.75 in/70 mm	
Operating Temperature	41° to 131° F (5° to 55° C)	

HP 1-TB SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)			
Formatted Capacity	1 TB		
Spindle Speed	5,400 rpm +/- 0.2%		
Drive Type	Solid State Hybrid Drive	(SSHD) technology with NAND Flash	
Interface	Serial ATA (SATA)		
Cache Buffer	64 MB	64 MB	
NAND Flash Commercial Multilevel Cell (cMLC)	8 GB		
Number of Sectors	976,773,168		
Sock Time (tunical roads)	Single Track:	2.0 ms	
Seek Time (typical reads)	Average:	12 ms	
Height	0.374 +/008 in (9.5 +/- 0.2 mm)		

Width	2.750 +/- 0.010 in (69.85 +/- 0.25 mm)	
Length	3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)	
Weight	0.254 lb/115 g (max)	
Operating Temperature	32° to 140° F (0° to 60° C)	

HP 500 GB SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)		
Formatted Capacity	500 GB	
Spindle Speed	5,400 rpm +/- 0.2%	
Drive Type	Solid State Hybrid Drive	(SSHD) technology with NAND Flash
Interface	Serial ATA (SATA)	
Cache Buffer	64 MB	
NAND Flash Commercial Multilevel Cell (cMLC)	8 GB	
Number of Sectors	976,773,168	
Seek Time (typical reads)	Single Track:	2.0 ms
Seek Time (typicat reads)	Average:	12 ms
Height	0.268 +/008 in (6.8 +/- 0.2 mm)	
Width	2.750 +/- 0.010 in (69.85 +/- 0.25 mm)	
Length	3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)	
Weight	0.209 lb/95 g (max)	
Operating Temperature	32° to 140° F (0° to 60° C)	

HP 500-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive		
Capacity	500,107,862,016 bytes	

Rotational Speed	7,200 rpm	
Interface	Serial ATA 3.0 (6.0 Gb/s)	
Buffer Size	16 MB	
Logical Blocks	976,773,168	
	Single Track:	2.0 ms
Seek Time (typical reads, includes controller overhead, including settling)	Average:	11 ms
	Full-Stroke:	21 ms
Height (nominal)	1 in/2.54 cm	
Width (nominal)	Media diameter: 3.5 in/8.89 cm	
width (Holliniat)	Physical size: 4 in/10.2 cm	
Operating Temperature	41° to 131° F (5° to 55° C)	

HP 120 GB Solid State Drive			
Unformatted Capacity	120 GB		
Architecture	Multi Level Cell (MLC) NAND Flash with wear leveling 10 channel controller		
Interface	Serial ATA 2.0 (3.0 Gb/s)		
Dimensions (W x H x D)	2.74 x 0.37 x 4 in (6.98 x 0.95 x 10.2 cm)		
Weight	0.18 lb (80 g)		
Bandwidth Performance	Sustained Sequential Read:	Up to 250 MB/s	
	Sustained Sequential Write:	Up to 70 MB/s	
	Random Read:	Up to 35K IOPs	
	Random Write:	Up to 6.6K IOPs	
Latency	Read:	65-ms	
	Write:	85-ms	
Power	DC power requirement:	5 VDC 5%-100 mV ripple p-p	
	Total power consumption:	0.15W (active); 0.075W (idle)	

Useful Drive Life	35TB written, up to 20GB/day for 5 years	
Environmental (all conditions, non-condensing)	Operating Temperature:	32° to 158° F (0° to 70° C)
	Relative Humidity:	5% to 95%
	Maximum Wet Bulb Temperature (operating):	84° F (29° C)
	Shock:	1,500 G/0.5-ms

^{*} For solid state disk drives, GB means 1 billion bytes. 128GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity will vary by content

^{**} The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.

HP 128 GB Solid State Drive				
Unformatted Capacity	128 GB*			
Architecture	Multi Level Cell (MLC) NAND			
Interface	SATA 6 GB/sec			
Dimensions (W x H x D)	2.75 x 0.276 x 3.96 in (6.985 x 0.7 x 10.05 cm)			
Weight	0.16 lb (73 g)			
Bandwidth Performance	Sustained Sequential Read:	Up to 450 MB/ss		
	Sustained Sequential Write:	Up to 260 MB/s		
	Random Read (4KB):	up to 46K IOPs		
	Random Write (4KB):	up to 56K IOPs		
Latency	Read:	55ms (TYP)		
	Write:	55ms (TYP)		
Power	DC power requirement:	Min 4.5 V; Max 5.5 V		
	Total power consumption:	160 mW (Active) ; <85 mW; (Idle)		
Useful Drive Life	1.2 million device hours**			
Environmental (all conditions, non-condensing)	Operating Temperature:	32° to 158° F (0° to 70° C)		
	Relative Humidity (operating):	5% to 95%		

Technical Specifications – Hard Disk and Solid State Storage

	Shock:	1,500 G/1.0 msec
Regulations	UL, CSA, EN 60950-2000, CISPR P CISPR 22:2002 Class B, Korea KCC	
* For solid state disk drives, GB means 1 billion bytes. 128GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity will vary by content		

^{**} The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.

HP 160 GB Solid State Drive			
Unformatted Capacity	160 GB*		
Architecture	Multi Level Cell (MLC) NAND		
Interface	SATA 3 GB/sec		
Dimensions (W x H x D)	2.74 x 0.37 x 4 in (6.98 x 0.95 x 10.2 cm)		
Weight	0.18 lb (80 g)		
	Sustained Sequential Read:	Up to 250 MB/s	
David Adal Davidson	Sustained Sequential Write:	Up to 70 MB/s	
Bandwidth Performance	Random Read (4KB):	up to 35K IOPs	
	Random Write (4KB):	up to 6.6K IOPs	
1-4	Read:	65 ms	
Latency	Write:	85 ms	
Davier	DC power requirement:	5 VDC 5%-100 mV ripple p-p	
Power	Total power consumption:	0.15 Watt (Active); 0.075 Watt (Idle)	
Useful Drive Life	35TB written, up to 20GB/day for 5 years **		
	Operating Temperature:	32° to 158° F (0° to 70° C)	
Environmental (all conditions, non-condensing)	Relative Humidity (operating):	5% to 95%	
	Shock:	1,500 G/0.5 msec	
Regulations	UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS 13438, AS/NZS CISPR 22:2002 Class B, Korea KCC, CE Mark		
* For solid state disk drives, GB means	1 billion bytes. 128GB is the unformatted capacity of this dr	ive before a portion of the drive is reserved fo	

flash management features. Actual capacity will vary by content

Technical Specifications – Hard Disk and Solid State Storage

** The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.

HP 256 GB SATA 2.5" Self-Encrypting (SED) Solid State Drive			
Unformatted Capacity	256,186,209,271 bytes		
Architecture	Self-Encrypting (SED) Solid State Drive with 25nm M	LC NAND Flash and SATA interface	
Interface	Serial ATA 2.0 (3.0 Gb/s)		
NAND Flash	25nm MLC NAND Flash		
Height	.275 in/7mm		
Width	2.75 in/69.85 mm		
Length	3.95 in/100.5 mm		
Weight	0.161 lb (73 g)		
	Sustained Sequential 128k Read:	Up to 450 MB/s	
Bandwidth Performance	Sustained Sequential 128k Write:	Up to 260 MB/s	
Danuwidth Ferrormante	Random 4k Read:	Up to 46K IOPs	
	Random 4k Write:	Up to 56K IOPs	
Latency	Read:	55 μs	
Lucency	Write:	55 μs	
Power	SATA power consumption: 160 mW (active average); <85 mW (idle average)		
Useful Drive Life	72TB written, up to 40GB/day for 5 years		
	Operating Temperature:	32° to 158° F (0° to 70° C)	
Environmental (all conditions, non-condensing)	Relative Humidity:	5% to 95%	
	Shock:	1,500 G/1 ms	

HP 500-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive		
Capacity	apacity 500,107,862,016 bytes	

Technical Specifications – Hard Disk and Solid State Storage

Rotational Speed	7,200 rpm	
Interface	Serial ATA 3.0 (6.0 Gb/s)
Buffer Size	16 MB	
Logical Blocks	976,773,168	
Seek Time (typical reads,	Single Track:	2.0 ms
includes controller overhead,	Average:	11 ms
including settling)	Full-Stroke:	21 ms
Height (nominal)	1 in/2.54 cm	
Width (nominal)	Media diameter: 3.5 in/8.89 cm	
with (nonlinar)	Physical size: 4 in/10.2 cm	
Operating Temperature	41° to 131° F (5° to 55° C)	

HP 1-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive			
Capacity	1,000,204,886,016 byte	es	
Rotational Speed	7,200 rpm		
Interface	Serial ATA 3.0 (6.0 Gb/s)	
Buffer Size	32 MB	32 MB	
Logical Blocks	1,953,525,168		
Seek Time (typical reads,	Single Track:	2.0 ms	
includes controller overhead, including settling)	Average:	11 ms	
including Settling)	Full-Stroke:	21 ms	
Height (nominal)	1 in/2.54 cm		
Width (nominal)	Media diameter: 3.5 in/8.89 cm		
widen (nonlinaty	Physical size: 4 in/10.2 cm		
Operating Temperature	41° to 131° F (5° to 55° C)		

Technical Specifications – Hard Disk and Solid State Storage

HP 2-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive		
Unformatted Capacity	2 TB	
Rotational Speed	7,200 rpm	
Interface	SATA 6Gb/s NCQ	
Cache, Multisegmented (MB)	64 MB	
	Read	<8.5 ms
Seek Time (average)	Write	<9.5 ms
Height	1.028 in/26.11 mm	
Width	4.0 in/101.6 mm	
Depth	5.787 in/146.99 mm	
Weight	1.38 lb/626 g	
Operating Temperature	32° to 140° F (0° to 60° (C)

HP Slim SuperMulti DVD Writer Drive		
Height	12.7mm height	
Orientation	Either horizontal or vertical	
Interface type	SATA/ATAPI	
Disc recording capacity	Up to 8.5 GB DL or 4.7 GB stand	ard
Dimensions (W x H x D)	5.04 x 0.5 x 5.0 in (128 x 12.7 x	127 mm) without bezel
Weight (max)	0.42 lb (190 g)	
	DVD-RAM	Up to 5X
	DVD-R DL	Up to 6X
	DVD+R	Up to 8X
	DVD+RW	Up to 8X
Write speeds	DVD+R DL	Up to 6X
	DVD-R	Up to 8X
	DVD-RW	Up to 6X
	CD-R	Up to 24X
	CD-RW	Up to 24X
	DVD-RAM	Up to 5X
	DVD-RW, DVD+RW	Up to 8X
	DVD-R DL, DVD+R DL	Up to 8X
Read speeds	DVD+R, DVD-R	Up to 8X
	DVD-ROM DL, DVD-ROM	Up to 8X
	CD-ROM, CD-R	Up to 24X
	CD-RW	Up to 24X
Access time	Random	DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)
(typical reads, including	Full Stroke	DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)
settling)	Stop Time	6 seconds (typical)
	Source	Slimline SATA DC power receptacle
Power	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p
	DC Current	5 VDC (< 1000 mA typical, 1600 mA maximum)
Environmental conditions	Temperature	41° to 122° F (5° to 50° C)

(operating - non-condensing)	Relative Humidity	10% to 80%	
	Maximum Wet Bulb Temperature	84° F (29° C)	
HP Slim Blu-ray BDXL Drive			
Height	12.7mm height		
Orientation	Either horizontal or vertical		
Interface type	SATA/ATAPI		
Disc recording capacity	Up to 128 GB QL, 100 GB TL, 50	GB DL or 25 GB standard SL	
Dimensions (W x H x D)	5.04 x 0.5 x 5.0 in (128 x 12.7 x	127 mm) without bezel	
Weight (max)	Up to 0.37 lb (170 g) without be	zel	
		Triple-layer	Quadruple-layer
	BD-R	Up to 4X	Up to 4X
	BD-RE	Up to 2X	Not supported
		Single-layer	Double-layer
	BD-R	Up to 6X	Up to 6X
	BD-RE	Up to 2X	Up to 2X
	DVD-R	Up to 8X	Up to 6X
	DVD-RW	Up to 6X	Not supported
	DVD+R	Up to 8X	Up to 6X
Write speeds	DVD+RW	Up to 8X	Not supported
write speeus	DVD-RAM	Up to 5X	
	CD-R	Up to 24X	
	CD-RW	Up to 24X	
		Triple-layer	Quadruple-layer
	BD-R	Up to 4X	Up to 4X
	BD-RE	Up to 4X	Not supported
		Single-layer	Double-layer
	BD-ROM	Up to 6X	Up to 6X
	BD-R	Up to 6X	Up to 6X
Read speeds	BD-RE	Up to 6X	Up to 6X
au speeus	DVD-ROM	Up to 8X	Up to 8X

	DVD-R	Up to 8X	Up to 8X
	DVD-RW	Up to 8X	
	DVD+R	Up to 8X	Up to 8X
	DVD+RW	Up to 8X	
	BDMV (AACS Compliant Disc)	Up to 6X/2X (Read/Play)	
	DVD-RAM	Up to 5X	
	DVD-Video (CSS Compliant Disc)	Up to 8X/4X (Read/Play)	
	CD-R/RW/ROM	Up to24X	
	CD-DA(DAE)	Up to 20X/10X (Read/Play)	
Access time	Random	BD-ROM: 205 ms (typical), DVD- CD-ROM: 165 ms (typical)	ROM: 185 ms (typical),
(typical reads, including settling)	Full Stroke	BD-ROM: 350 ms (typical), DVD-CD-ROM: 340 ms (typical)	ROM: 345 ms (typical),
	Source	Slimline SATA DC power recepta	cle
Power	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p	
	DC Current	5 VDC -1200 mA typical, 2000 mA maximum	
Environmental conditions (operating - non-condensing)	Temperature	41° to 122° F (5° to 50° C)	
	Relative Humidity	10% to 80%	
	Maximum Wet Bulb Temperature	84° F (29° C)	

HP Slim DVD-ROM Drive			
Height	12.7mm	12.7mm	
Orientation	Either horizontal or vertical		
Interface type	SATA/ATAPI		
Dimensions (W x H x D)	5.04 x 0.5 x 5.0 in (128 x 12.7 x 127 mm) without bezel		
Weight (max)	Up to 0.37 lb (170 g) without bezel		
	DVD+R/-R/+RW/ -RW/+R DL /-R DL	Up to 8X	
Read speeds	DVD-ROM Up to 8X		
	CD-ROM, CD-R	Up to 24X	
	CD-RW Up to 24X		

Access time	Random	DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)	
(typical reads, including settling)	Full Stroke	DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)	
	Source	Slimline SATA DC power receptacle	
Power	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p	
	DC Current	5 VDC - <1000 mA typical, < 1600 mA maximum	
	Temperature	41° to 122° F (5° to 50° C)	
Environmental (all conditions non-condensing)	Relative Humidity	10% to 80%	
	Maximum Wet Bulb Temperature (operating)	84° F (29° C)	

Technical Specifications – Memory

System Memory Support

The HP EliteDesk 800 G1 Business PC supports the 4th generation Intel® Core™ processor family. Based on a new PC microarchitecture, the processor is designed for a two-chip platform consisting of a processor and Platform Controller Hub (PCH). Unlike previous generations, the 4th generation Intel® Core™ processor includes an Integrated Memory Controller (IMC). The IMC supports DDR3/DDR3L protocols with two independent, 64-bit wide channels each accessing one or two DIMMs.

- Two channels of non-ECC DDR3/DDR3L unbuffered dual in-line memory modules (UDIMM) or DDR3/DDR3L unbuffered small outline dual in-line memory modules (SO-DIMM) with a maximum of two DIMMs per channel
- Single-channel and dual-channel memory organization modes
- Data burst length of eight for all memory organization modes
- Memory data transfer rates of up to 1600 MT/s; actual supported data transfer rate determined by the configured processor.
- 64-bit wide channels
- DDR3/DDR3L system memory I/O voltage of 1.5V
- Theoretical maximum memory bandwidth of:
 - o 21.3 GB/s in dual-channel mode assuming 1333 MT/s
 - 25.6 GB/s in dual-channel mode assuming 1600 MT/s

Platform Memory Support

- The Small Form Factor (SFF) and Tower (TWR) platforms support up to four (4) industry-standard DDR3-SDRAM DIMMs.
- The Ultra-slim Desktop (USDT) and Desktop Mini (DM) support up to two (2) industry-standard DDR3-SDRAM SO-DIMMs.

CAUTION: You must shut down the computer and disconnect the power cord before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the computer is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board.

NOTE: For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.

Technical Specifications – Networking and Communications

Connector	RJ-45			
System Interface	Integrated on PCA	Integrated on PCA		
Controller	Intel I217LM GbE platform LAN co	nnect networking controller		
Memory	24 KB FIFO packet buffer memory	1		
Data rates supported	10/100/1000 Mbps			
IEEE Compliance	802.1P 802.1Q 802.2 802.3 802.3ab 802.3az 802.3u	802.1Q 802.2 802.3 802.3ab 802.3az		
Bus architecture	PCI Express and SMBus			
Data transfer mode	I	PCIe-based interface for active state operation (S0 state) and SMBus for host and management traffic (Sx low power state)		
Power requirement	Requires 3.3V and 0.9V or just 3.3 Power consumption 0.733 Watts	Requires 3.3V and 0.9V or just 3.3V with integrated regulators Power consumption 0.733 Watts		
Boot ROM support	Yes	Yes		
Network transfer mode	Full-duplex Half-duplex (not supported for th	Full-duplex Half-duplex (not supported for the 1000BASE-T transceiver)		
	10BASE-T (half-duplex) 10 Mbps			
	10BASE-T (full-duplex) 20 Mbps	10BASE-T (full-duplex) 20 Mbps		
Network transfer rate	100BASE-TX (half-duplex) 100 M	bps		
	100BASE-TX (full-duplex) 200 Mb	100BASE-TX (full-duplex) 200 Mbps		
	1000BASE-T (full-duplex) 2000 N	1000BASE-T (full-duplex) 2000 Mbps		
Fundamental	Operating Temperature:	0° to 85° C		
Environmental	Operating Humidity:	60 % RH		
	WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced cable diagnostic			

Technical Specifications – Networking and Communications

Alerting ASF 2.0 support; AMT 9.0 support

Intel® Ethernet I210-T	1 Gigabit Network Adapter	
Connector	RJ-45	
System Interface	PCI Express x1	
Controller	Intel® I210 Gigabit Ethernet Controller	
Memory	Integrated Dual 48K configurable transmit receive FIFO Buffers	
Data rates supported	10/100/1000 Mbps	
IEEE Compliance	802.1P 802.1Q 802.2 802.3 802.3AB 802.3u 802.3x flow control	
Bus architecture	PCI-E 2.1	
Data path width	X1, 250 MB/s, Bi-directional interface	
Data transfer mode	Bus-master DMA	
Hardware certifications	FCC, B, CE, TUV-c, TUVus Mark Canada and United States, TUV-GS Mark for European Union	
Power requirement	Aux 3.3 V, 3.0 Watts in 1000 base-T and 1.0 Watts in 100 Base-T	
Boot ROM support	Yes 10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps	
	10BASE-T (half-duplex) 10 Mbps	
	10BASE-T (full-duplex) 20 Mbps	
Network transfer rate	100BASE-TX (half-duplex) 100 Mbps	
	100BASE-TX (full-duplex) 200 Mbps	
	1000BASE-T (full-duplex) 2000 Mbps (actual rate limited by PCI bus)	

Technical Specifications – Networking and Communications

F	Operating Temperature: 32° to 132° F (0° to 55° C)		
Environmental	Operating Humidity: 85% at 131° F (55° C)		
Management	WOL, PXE, DMI, WFM 2.0		
Intel Centrino Advance-N 6205 Wireless Network Interface Connection			
Wireless LAN Standards IEEE 802.11a/b/g/n			
	IEEE 802.11 e, 802.11i, 802.11d, 802.11h		
Interoperability	Wi-Fi certified (802.11 a/b/g/n WMM, WPA, WPA2 and WPS)		
	Tested with wireless access points from several major manufacturers		
	OS compatible with Microsoft Windows, Win7 and XP		
	Cisco Compatible Extensions Program compliant (802.11a/b/g only) with Microsoft Windows XP and Windows 7		
Frequency Band	2.4 GHz and 5 GHz		
Antenna Structure	2 transmit; 2 receive (2x2)		
Data Rates	802.11b: 1, 2, 5.5, 11 Mbps		
	802.11a/g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps		
	802.11n: 66 possible data rates, ranging from 6 Mbps to 300 Mbps, depending on the combination of Bandwidth, Modulation Coding Scheme, and Guard Interval used, as defined in IEEE 802.11n specification		
Modulation	Direct Sequence Spread Spectrum DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM		
Security	Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES (support for key sizes of 128bits), TKIP, 802.1x authentication types EAP-TLS, EAP-TTLS, PEAP, MSCHAP, PEAP-MSCHAPv2, LEAP, EAP-FAST, EAP-SIM, EAP-AKA PAP, CHAP, TLS, GTC		
	Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program Version 4) with Microsoft Windows XP only.		
Sub-channels	Multinational support with frequency bands and channels compliant to local regulations.		
Media Access Protocol	CSMA/CA (Collision Avoidance) with ACK		
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required) Intel® My Wifi Technology (iPAN)		
Roaming	Provide seamless roaming between like access points (same frequency band)		

Technical Specifications – Networking and Communications

Output Power (for CCK)	15 dBm			
Output Power (for OFDM; power varies by data rate)	15 dBm			
Power Consumption	Transmit: 2.3 Watts (average, with one spatial streams)			
	Receive: 1.9 Watts (average with two receive chains)			
	Idle mode: 30mW – 40mW (average)			
	Radio off: 20 mW (max)			
Power Management	ACPI compliant power management 802.11 compliant power saving mode			
Antenna Connections	3 U.FL type connectors, 50 ohm nominal impedance			
Range	802.11 a - Typical (@6 Mbps) 600 feet - Outdoor Open Area 150 feet - Indoor, Office environment			
	802.11 b - Typical (@1 Mbps) 1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment			
	802.11 g - Typical (@1 Mbps) 1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment			
Form Factors	USDT: MiniPCI-Express			
	CMIT & SFF: PCIe			
Weight	0.013 lb (4.0 g)			
Dimensions	1.1 x 1.2 in (26.8 x 30.0 mm)			
Operating Voltage	3.3V +/- 9%, 1.5V +/- 5%			
Temperature	Operating: 32° to 176° F (0° to 80° C) Non-operating: -40° to 176° F (-40° to 80° C)			
Humidity	Operating:10% to 90% (non-condensing)Non-operating:5% to 90% (non-condensing)			
	Microsoft Windows XP Microsoft Windows Win 7			
Configuration Utility	 Microsoft Windows XP Wireless Network Connection Manager Intel PROSet for Microsoft Windows XP (required for Cisco Compatible Extensions support) 	Intel IHV extensions for Win7 available to support Cisco Compatible Extensions		

Technical Specifications - Audio

High Definition Audio			
Туре	Integrated		
HD Stereo Codec	Realtek 2-channel ALC221 codec		
Audio I/O Ports	Front microphone-In (150-K ohm Input Impedance)		
	Rear Line-In/Microphone input (150-K ohm Input Impedance, function is configurable by audio driver)		
	Rear Line-Out* (190 ohms Output Impedance, expects at least a 10-K ohm load)		
	Front Headphone-Out (0.5 Ohm Output Impedance, expects at least a 32 ohm load) Front Microphone/Headphone jack is re-task able to provide Microphone input, line-in or Headphone output to support connecting two headphones to the front of the system. When configured as a second front headphone output, both front headphone outputs are always driven with the same signal.		
	All ports are 3.5mm		
Internal Speaker Amplifier	1.5W amplifier for the internal speaker only. External speakers must be powered externally. Rear Line-in audio port is re-taskable as either Line-in or Microphone-In.		
Multi-streaming Capable	Multi-streaming can be enabled in the Realtek control panel to allow independent audio streams to be sent to/from the front and rear jacks.		
Sampling	8 kHz - 192 kHz		
Wavetable Syntheses	Yes – Uses OS soft wavetable		
Analog Audio	Yes		
# of Channels on Line-Out	Stereo (Left & Right channels)		
Internal Speaker	Yes		
External Speaker Jack	Yes		

HP USB Keyboard			
	Keys	104, 105, 106, 107, 109 layout (depending upon country)	
Physical characteristics	Dimensions (L x W x H)	18.12 x 6.47 x 0.96 in (46.03 x 16.43 x 2.44 cm)	
	Weight	2 lb (0.9 kg)	
	Operating voltage	+ 5VDC ± 5%	
	Power consumption	50-mA maximum (with three LEDs ON)	
Floatvical	System interface	USB Type A plug connector	
Electrical	ESD	CE level 4, 15-kV air discharge	
	EMI - RFI	Conforms to FCC rules for a Class B computing device	
	Microsoft® PC 99 - 2001	Functionally compliant	
	Keycaps	Low-profile design	
	Switch actuation	55-g nominal peak force with tactile feedback	
	Switch life	20 million keystrokes (using Hasco modified tester)	
Mechanical	Switch type	Contamination-resistant switch membrane	
	Key-leveling mechanisms	For all double-wide and greater-length keys	
	Cable length	6 ft (1.8 m)	
	Microsoft PC 99 - 2001	Mechanically compliant	
	Acoustics	43-dBA maximum sound pressure level	
Environmental	Operating temperature	50° to 122° F (10° to 50° C)	
	Non-operating temperature	-22° to 140° F (-30° to 60° C)	
	Operating humidity	10% to 90% (non-condensing at ambient)	
	Non-operating humidity	20% to 80% (non-condensing at ambient)	
	Operating shock	40 g, six surfaces	

	Non-operating shock	80 g, six surfaces	
	Operating vibration	2-g peak acceleration	
	Non-operating vibration 4-g peak acceleration		
	Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence		
	Drop (in box)	30 in (76.2 cm) on concrete, 16-drop sequence	
Approvals	UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, KC		
Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and TUVGS		
Kit contents	Keyboard Installation Guide		
	Warranty Card Safety and Comfort Guide		

HP PS/2 Keyboard			
Physical Characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)	
	Dimensions (L x W x H)	18.22 x 6.47 x 1.1 in (46.28 x 16.43 x 2.79 cm)	
	Weight	2 lb (0.9 kg) minimum	
	Operating voltage	+ 5VDC ± 10%	
	Power consumption	50-mA maximum (with three LEDs ON)	
	System interface	PS/2 6-pin mini din connector	
Electrical	ESD	CE level 4, 15-kV air discharge	
	EMI - RFI	Conforms to FCC rules for a Class B computing device	
	Microsoft PC 99 - 2001	Functionally compliant	
	Keycaps	Low-profile design	
	Switch actuation	55-g nominal peak force with tactile feedback	
	Switch life	20 million keystrokes (using Hasco modified tester)	
	Switch type	Contamination-resistant switch membrane	
	Key-leveling mechanisms	For all double-wide and greater-length keys	

	Cable length	6 ft (1.8 m)	
	Microsoft PC 99 - 2001	Mechanically compliant	
	Acoustics	50-dBA maximum sound pressure level	
	Operating temperature	32° to 104° F (0° to 40° C)	
	Non-operating temperature	-22° to 149° F (-30° to 65° C)	
	Operating humidity	15% to 80% (non-condensing at ambient)	
	Non-operating humidity	15% to 90% (non-condensing at ambient)	
	Operating shock	N/A	
Environmental	Non-operating shock	65 inch 2.9 ms, six surface; 30g 266 inch/second; 50g 266 inch/second six surface	
	Operating vibration	2-g peak acceleration	
	Non-operating vibration	Starting at 5 Hz, vary the frequency of vibration from 5 to 500 Hz and back to 5 Hz at a Logarithmic sweep rate of 1 octave per minute.	
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence	
	Drop (in box)	29.93 in (76 cm) on concrete, 16-drop sequence	
Approvals	CUL, ICES-003 Class B, FCC, CE Mark, TUV GS, VCCI, BSMI, C-Tick, KC		
Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and TUVGS		

HP USB Smart Card (CCID) Keyboard		
Key Benefits:	 Protects against unauthorized access with smart card technology Delivers even greater security when combined with a HP ProtectTools smart card and the HP ProtectTools Security Software Combination of username and password or pin with a smart card or security token Secures online transactions using digital signatures and certificates Conforms to industry standards for ease of setup and use Delivers long product life and quiet operation with high-impact materials and lubricated keys Spill drain feature 	

	Keys	104, 105, 106, 107, 109 layout (depending upon country	
Physical Characteristics	Form factor	USB basic smart card keyboard	
	Colors	Carbonite/Silver	
	Dimensions (H x W x D)	18.2 x 6.3 x 1.3 in (46.3 x 16.1 x 3.3 cm)	
	Weight	2 lb (0.9 kg) minimum	
	Operating voltage	+ 5VDC ± 5%	
	Power consumption	100-mA maximum (with four LEDs ON)	
Floatsiaal	System interface	USB Type A plug connector	
Electrical	ESD	CE level 4, 15-kV air discharge	
	EMI - RFI	Conforms to FCC rules for a Class B computing device	
	Microsoft PC 99 - 2001	Functionally compliant	
	Languages	30+ available	
	Keycaps	Standard design	
	Switch actuation	55 g nominal peak force with tactile feedback	
Mechanical	Switch life	20 million keystrokes (using Hasco modified tester)	
	Switch type	Contamination-resistant membrane	
	Key-leveling mechanisms	For all double-wide and greater-length keys	
	Cable length	6 ft (1.8 m)	
	Microsoft PC 99 - 2001	Mechanically compliant	
	Acoustics	43-dBA maximum sound pressure level	
	Operating temperature	50° to 122° F (10° to 50° C)	
Environmental	Non-operating temperature	-22° to 140° F (-30° to 60° C)	
	Operating humidity	10% to 90% (non-condensing at ambient)	
	Non-operating humidity	20% to 80% (non-condensing at ambient)	

	Operating shock	40 g, six surfaces	
	Non-operating shock	80 g, six surfaces	
	Operating vibration	2-g peak acceleration	
	Non-operating vibration	4-g peak acceleration	
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence	
	Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence	
	Support	All ISO 7816 smart cards	
	Interface	Reads from and writes to all ISO7816-1, 2, 3, 4 memory and microprocessor smart cards (T=0, T=1)	
	Chipset	SCM STCII	
	Standard APIs supported	PC/SC, EMV2000, SET	
		USB Port	
	Power	Short circuit detection (protects smart card and reader)	
		Power supply compliant (mA)	with IS07816 and EMV (5V, 60
SmartCard Function		Supports 3-V and 5-V cards	
	Power consumption	100-mA maximum draw	
	Communication	From card	9600 bps to 330,000 bps
		From computer	12 Mbps (USB transfer speed)
		Contact device	Friction contact
	Landing mechanism	Card insertions rating	Up to 100,000 insertion cycles
	Interface modes	CCID protocol	
	Reader performance interface	USB connection	
	Electro-magnetic standards	Europe	2004/108/EC

		USA	USAFCC part 15	
Approvals	CE-Mark, UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC, EMV2000, USB-IF			
Ergonomic Compliance	150 9241-4, 10VGS	ISO 9241-4, TUVGS		
Kit Contents	Keyboard, I/O Security and Docu	umentation CD, warranty	<i>y</i> card	
HP USB PS/2 Washab	le Keyboard			
	Keys	104 (US) Layout, 105 (EU) layout – depending upo country		
Physical Characteristics	Dimensions (L x W x H)	17.67x 6.62 x 1.38 ir	n (449 x 168 x 35 mm)	
	Weight	1.7 lb (0.77 kg) minii	mum	
	Operating voltage	+ 5VDC ±5%		
	Power consumption	50-mA maximum (w	ith three LEDs ON)	
Electrical	System interface	USB Type A plug connector		
Electricat	ESD	CE level 4, 15-kV air discharge		
	EMI - RFI	Conforms to FCC rules for a Class B computing device		
	Microsoft PC 99 - 2001	Functionally compliant		
	Keycaps Stepped -profile design		ign	
	Switch actuation	55-g nominal peak force with tactile feedback		
	Switch life	20 million keystrokes		
Mechanical	Switch type	Contamination-resistant switch membrane		
mechanicat	Key-leveling mechanisms	For all double-wide and greater-length keys		
	Cable length	7 ft (2.2 m)		
	Microsoft PC 99 - 2001	Mechanically compli	ant	
	Acoustics	43-dBA maximum so	ound pressure level	
	Operating temperature	50° to 122° F (10° to 50° C)		
Environmental	Non-operating temperature	4° to 149° F (-20° to 65° C)		
	Operating humidity	10% to 95% (non-condensing at ambient)		
	Non-operating humidity	0% to 95% (non-con	densing at ambient)	
	Operating shock	40 g, six surfaces		
	Non-operating shock	80 g, six surfaces		
	Operating vibration	2-g peak acceleration		
	Non-operating vibration	4-g peak acceleratio	n	

	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence
	Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence
Operating system support	Windows® 7, Windows Vista, Windows XP Professional	
Approvals	UL, cUL, FCC, CE, TUV GS, VCCI, BSMI, C-Tick, KCC, USB-IF, WHQL, EN/IEC 60601-1, IP66/NEMA4X	
Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and TUVGS	

HP Wireless Keyboard and Mouse		
	Dimensions (H x L x W)	1.09 x 18.1 x 6.47 in (27.87 x 460.3 x 164.3 mm)
Keyboard	Weight — Without Two AA Alkaline Batteries	1.94 lb (880 g)
	Dimensions (H x L x W)	1.46 x 4.53 x 2.47 in (37 x 115 x 62.9 mm)
Mouse	Weight — Without Two AA Alkaline Batteries	0.15 lb (67 g)
	Dimensions (H x L x W)	0.33x 1.79 x 0.72 in (8.4 x 45.5 x 18.4 mm)
Receiver	Weight	0.21 oz (5.9 g)
Receivei	Cable Length – Minimum	6 ft (1.8 m)
	Range	32.8 ft (10 m)
System Requirements	Windows 7 Home Basic*, Windows 7 Home Premium*, Windows 7 Professional Edition 32*, Windows 7 Professional Edition 64*, Windows 7 Ultimate Edition 32*, Windows 7 Ultimate Edition 64* Windows Vista or Windows XP Available USB port for the receiver CD-ROM Drive *This system may require upgraded and/or separately purchased hardware and/or a DVD drive to install the Windows 7 software and take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.	
	Product Safety	UL; CSA /TUV (Europe only); CE Mark; CB Report
	Ergonomics	ANSI; ISO (Europe only); GS Mark (Germany only)
	EMC	FCC; CE; ACA (-tick); BSMI; KC ; VCCI
	CE Mark	EN 55022:2010; EN 55024; EN 301489-1; EN 61000
Approvals	Design Guidelines for PCs PC 99 – connector overmold colors; PC 200 functionality	
	Telecom	All local telecom requirements and approvals for intended markets
	USA	FCC Title 47 CFR, Par 15, Subpart C; other local requirements

	Country Support	US, Belgium, Switzerland, Spain, Denmark, Netherlands, France, Germany, Italy, Portugal, Sweden, Norway, Finland, UK, Poland, Czech Republic, Turkey, Greece, Austria, Bulgaria, Cyprus, Estonia, Hungary, Ireland, Latvia, Lithuania, Luxemburg, Malta, Romania, Slovakia, Slovenia, Vietnam, HK, Australia, NZ, Malaysia, Singapore, Indonesia, Philippines, Thailand, Canada, China, Japan, Korea, Taiwan, India, Venezuela, Ecuador, Russia, Ukraine, Israel, Croatia, United Arab Emirates, Peru, Brazil, Chile, Argentina, Mexico, South Africa, and up to 193 countries worldwide.
Environmental	Keyboard contains 25% post-consumer recycled plastic material.	

HP PS/2 Mouse		
Dimensions (H x L x W)	1.46 x 2.48 x 4.53 in (3.70 x 6.29 x 11.50 cm)	
Weight	3.53 oz (100g; +10g/- 5 g)	
	Operating temperature	-32° to 104°F (0° to 40° C)
	Non-operating temperature	-4° to 140°F (-20° to 60° C)
	Operating humidity	10% to 90% (non condensing at ambient)
	Non-operating humidity	10% to 90% (non condensing at ambient)
Environmental	Operating shock	40 g, 6 surfaces
	Non-operating shock	80 g, 6 surfaces
	Operating vibration	2 g peak acceleration
	Non-operating vibration	4 g peak acceleration
	Drop (out of box)	80 cm height onto asphalt tile over concrete or equivalent, 5-drop in 5 direction except the cable face
Electrical	Operating voltage	5 VDC ± 10%
Liettricat	Power consumption	100mA

	System consumption	PS/2 mini-din connector	
	ESD	CE level 4, 15 kV air discharge	
	EMI-RFI	Conforms to FCC rules for a Class B computing device	
	Microsoft PC99 - 2001	Functionally compliant	
	Resolution	800 DPI	
	Tracking speed 10 in/s (25.4 cm/s) maximum		
	Acceleration	±15%	
	Switch actuation	65±20 gf	
Mechanical	Switch life	3,000,000 operations (using Hasco modified tester)	
	Switch type Low force micro-switches		
	Tracking mechanism life	80 km	
	Cable length	6 ft (1.8 m)	
	Microsoft PC99 - 2001	Mechanically compliant	
	Width	6 mm	
	Diameter	22.5 ± 0.2 mm	
Scroll wheel	Maximum rotation force	50 gf-cm	
Scrott wheet	Switch type	Light force micro-switch	
	Switch life	1 million operations	
	Mechanical life	Minimum 200,000 revolutions	
Regulatory Approvals	UL/cUL, FCC, CE Mark, TUV/GS, VCCI, KCC, BSMI, C-Tick		

HP USB Mouse		
Dimensions (H x L x W)	1.5 x 4.5 x 2.5 in (3.7 x 11.5 x 6.3 cm)	
Weight	0.22 lb (0.10 kg)	

Cable length	70.9 in (180 cm)
System requirements	Available USB port

HP USB 1000dpi Laser Mouse				
Dimensions (H x L x W)	1.47 x 4.53 x 2.47 in (37.3 x 114	1.47 x 4.53 x 2.47 in (37.3 x 114.97 x 62.86 mm)		
Weight	3.360 oz (102g)			
Cable length	70.9 in (180 cm)	70.9 in (180 cm)		
System requirements	Available USB port	Available USB port		
	Operating Temperature	32° to 104° F (0° to 40° C)		
Environmental	Non-operating Temperature	-4° to 140° F (-20° to 60° C)		
Livioniientut	Operating Humidity	10% to 90% (non-condensing at ambient)		
	Resolution	1000dpi		
Mechanical	Tracking Speed	45 cm/sec		
	Cable Length	70.9 in (180 cm)		

HP USB PS/2 Washable Mouse			
Dimensions (H x L x W)	1.56 x 2.44 x 4.61 in	1.56 x 2.44 x 4.61 in (3.95 x 6.21 x 11.7 cm)	
Weight	4.44 oz (126 g)		
	Operating temperature	-32° to 104°F (0° to 40° C)	
Environmental	Non-operating temperature	-4° to 140°F (-20° to 60° C)	
	Operating humidity 10% to 90% (non-condensing at ambient)		

	Non-operating humidity	10% to 90% non-condensing
	Operating shock	40 g, 6 surfaces
	Non-operating shock	80 g, 6 surfaces
	Operating vibration	2 g peak acceleration
	Non-operating vibration	4 g peak acceleration
	Drop (out of box)	80 cm height onto asphalt tile over concrete or equivalent, 5-drop in 5 direction except the cable face
	Operating voltage	5 VDC ± 10%
	Power consumption	100mA
Electrical	System consumption	PS/2 mini-din connector or USB
	ESD	CE level 2 8 kV air discharge
	EMI-RFI	Conforms to FCC rules for a Class B computing device
	Microsoft PC99 - 2001	Functionally compliant
	Resolution	1000 ± 20% DPI
	Tracking speed	14 in/s (35.56 cm/s) maximum
	Acceleration	2 g
	Switch actuation	70 g nominal peak force
Mechanical	Switch life	3,000,000 operations (using Hasco modified tester)
	Switch type	Low force micro-switches
	Tracking mechanism life	8.8 ft total 70 cm+ 2m extension
	Cable length	Mechanically compliant

	Microsoft PC99 - 2001	1000 ± 20% DPI
	Width	6 mm
	Diameter	1 in (25.4 mm)
Scroll wheel	Maximum rotation force	48 rats/sec
	Switch type	Light force micro-switch
	Switch life	3 million operations
	Mechanical life	Minimum 200,000 revolutions
Regulatory Approvals	FCC, CE Mark, ICES-003-B, IP66/NEMA4X	

Technical Specifications – Power

Unit Environment and Operating Conditions

General Unit Operating Guidelines

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range.
- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's re-circulated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.

Temperature Range Operating: 50° to 95° F (10° to 35° C)*
Non-operating: -22° to 140° F(-30° to 60° C)

Relative Humidity Operating: 10% to 90% (non-condensing at ambient)
Non-operating: 5% to 95% (non-condensing at ambient)

Maximum Operating: 10,000 ft (3048 m)
Altitude (unpressurized) Non-operating: 30,000 ft (9144 m)

^{*}Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.

Power Supply	DM		USDT	SFF	TWR
Standard Efficiency	65W active PFC 87% efficient	Integrated graphics: Discrete graphics:	135W active PFC 87% efficient 180W active PFC 87% efficient	240W active PFC	320W active PFC
				240W active PFC	320W active PFC
80 PLUS Gold	N/A	N/A		87/90/87% efficient at 20/50/100% load (115V)	87/90/87% efficient at 20/50/100% load (115V)
				89/91/90% efficient at 20/50/100% load (230V) 240W active PFC	89/92/90% efficient at 20/50/100% load (230V) 320W active PFC
80 PLUS Platinum	N/A	N/A		90/92/89% efficient at 20/50/100% load (115V)	90/92/89% efficient at 20/50/100% load (115V)
				90/93/91% efficient at 20/50/100% load (230V)	90/94/91% efficient at 20/50/100% load (230V)
Operating Voltage Range	90 - 264 VAC	90 - 264 VAC		90 - 264 VAC	90 - 264 VAC
Rated Voltage Range	100 - 240 VAC	100 - 240 VAC		100 - 240 VAC	100 - 240 VAC
Rated Line Frequency	50/60 Hz	50/60 Hz		50/60 Hz	50/60 Hz
Operating Line Frequency	47 – 63 Hz	47 – 63 Hz		47 – 63 Hz	47 – 63 Hz
Rated Input Current	N/A	N/A		4A	5.5A
Rated Input Current with		135W: 2.4A		4A	5.5A

Total Cord Length

N/A

12 ft 8 in

Energy Efficient* Power Supply		180W: 2.9A		
Current Leakage (NFPA 99)	< 250 μΑ	< 250 μΑ	< 275 μA	<450=>275uA
Power Supply Fan	N/A	N/A	92=>70mm variable speed	92mm variable speed
Power cord length	N/A	N/A	6.0 ft. (1.83 m)	6.0 ft. (1.83 m)
External Power Adapter				
Dimensions		6.7 x 2.6 x 1.5 in	N/A	N/A

N/A

12 ft 8 in

Technical Specifications – Weights & Dimensions

Weights & Dimensions

(configured with 1 HDD & 1 ODD; DM configured with 1 HDD only)

	<u>DM</u>	<u>usdt</u>	<u>SFF</u>	<u>TWR</u>
Chassis (W x H x D)	6.9 x 1.3 x 7.0 in 175 x 34 x 177 mm	9.9 x 2.6 x 10 in 251 x 66 x 254 mm	13.3 x 3.95 x 14.9 in 338 x 100 x 379 mm	6.7 x 15.7 x 17.4 in 170 x 399 x 442 mm
System Volume	62.79 cu in 1.05 L	257.5 cu in 4.2 L	782.7 cu in 12.8 L	1828 cu in 30 L
System Weight*	2.9 lb 1.3 kg	6.8 lb 3.1 kg	16.7 lb 7.6 kg	20.5 lb 9.3 kg
Max Supported Weight (desktop orientation)	N/A	77.0 lb 35.0 kg	77.0 lb 35.0 kg	77.0 lb 35.0 kg
Tower Stand (H x W x D)	Pending	1.1 x 4.9 x 6.7 in 27 x 125 x 170 mm	1.1 x 7.0 x 7.9 in 29 x 178 x 200 mm	N/A
Packaging (H x W x D)	Pending	8.6 x 15.7 x 19.7 in 218 x 398 x 500 mm	9.0 x 19.7 x 23.4 in 229 x 500 x 594 mm	11.6 x 19.7 x 23.2 in 295 x 500 x 590 mm
Shipping Weight	Pending	14.4 lb 6.5 kg	17.9 lb 8.1 kg	28.8 lb 13.1 kg
Palletization Profile	Pending	6-units per layer 10-layer max. 60-units per pallet	4-units per layer 10-layer max. 40-units per pallet	4-units per layer 8-layer max. 32-units per pallet

Technical Specifications – Miscellaneous Features

Management Features

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode.
 Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
- Intel Wired for Management support; industry wide initiative to make Intel architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button

Serviceability Features

- Dual colored power LED on front of computer to indicate either normal or fault condition
- Diagnostic LED Explanation Table:
 - Number of 1-second red LED blinks followed by a 2-second pause, then repeats:
 - 2 processor thermal protection activated
 - 3 processor not installed
 - 4 power supply failure
 - 5 -- memory error
 - 6 video error
 - 7 PCA failure (ROM detected failure prior to video)
 - 8 invalid ROM, boot block recovery mode
 - 9 system not fetching code
 - 10 system hang while loading an option ROM
- HP PC Hardware Diagnostics UEFI:
 - This utility enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support
- System/Emergency ROM
- Flash ROM
- CMOS Battery Holder for easy replacement
- Flash Recovery with Video Configuration Record Software
- 5 Aux Power LED on System PCA
- Processor ZIF Socket for easy Upgrade
- Over-Temp Warning on Screen (Requires IM Agents)
- Clear Password Jumper
- DIMM Connectors for easy Upgrade
- Clear CMOS Button
- NIC LEDs (integrated) (Green & Amber)
- Dual Color Power and HD LED To Indicate Normal Operations and Fault Conditions
- Color coordinated cables and connectors
- Tool-less Hood Removal
- Front power switch
- System memory can be upgraded without removing the system board or any internal components
- Tool-less Hard Drive, CD & Diskette Removal
- Green Pull Tabs, and Quick Release Latches for easy Identification

Additional Features

Drive Protection System

Technical Specifications – Miscellaneous Features

Drive Lock

Implementation of the industry standard ATA Security feature set. When enabled, it prevents software access to user data on the drive until one or two user-defined passwords are provided.

DPS Access through F10 Setup during Boot

A diagnostic hard drive self-test. It scans critical physical components and every sector of the hard drive for physical faults and then reports any faults to the user

Running independently of the operating system, it can be accessed through a Windows-based diagnostics utility or through the computer's setup procedure. It produces an evaluation on whether the hard drive is the source of the problem and needs to be replaced

The system expands on the Self-Monitoring, Analysis, and Reporting Technology (SMART), a continuously running systems diagnostic that alerts the user to certain types of failures

SMART Technology (Self-Monitoring, Analysis and Reporting Technology)

Allows hard drives to monitor their own health and to raise flags if imminent failures were predicted

Predicts failures before they occur. Tracks fault prediction and failure indication

SMART I - Drive Failure Prediction

parameters such as re-allocated sector count, spin retry count, calibration retry count

By avoiding actual hard drive failures, SMART hard drives act as "insurance" against

unplanned user downtime and potential data loss from hard drive failure

SMART III - Off-Line Read Scanning with Defect Reallocation IOEDC: I/O Error Detection Circuitry

Detects errors in Read/Write buffers on HDD cache RAM

SMART IV - End-to-End CRC for hard drives

Interface in F10 setup provides confirmation of SMART IV support.

Technical Specifications - Environmental Data

Environmental Data

Eco-Label
Certifications
& Declarations

This product series has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- US ENERGY STAR®
- IT ECO declaration
- EPEAT® Gold where HP registers commercial desktop products. See http://www.epeat.net for registration status in your country.

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data is based on a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Model	Energy Consumption (typically configured)	115 VAC	230 VAC	100 VAC
DM	Normal Operation	Pending	Pending	Pending
	Sleep (ENERGY STAR® low power mode)	Pending	Pending	Pending
	Off	Pending	Pending	Pending
USDT	Normal Operation	15.16 W	15.72 W	15.08 W
	Sleep (ENERGY STAR® low power mode)	0.98 W	1.01 W	0.97 W
	Off	0.80 W	0.83 W	0.80 W
SFF	Normal Operation	22.90 W	22.78 W	23.08 W
	Sleep (ENERGY STAR® low power mode)	1.64 W	1.73 W	1.64 W
	Off	0.70 W	0.77 W	0.70 W
TOWER	Normal Operation	25.74 W	28.27 W	26.01 W
	Sleep (ENERGY STAR® low power mode)	1.66 W	1.76 W	1.65 W
	Off	0.68 W	0.78 W	0.67 W

Note: Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Model	Heat Dissipation*	115 VAC	230 VAC	100 VAC
DM	Normal Operation	Pending	Pending	Pending
	Sleep	Pending	Pending	Pending

Technical Specifications – Environmental Data

	Off	Pending	Pending	Pending
USDT	Normal Operation	52 BTU/hr	54 BTU/hr	64 BTU/hr
	Sleep	3 BTU/hr	3 BTU/hr	3 BTU/hr
	Off	3 BTU/hr	3 BTU/hr	3 BTU/hr
SFF	Normal Operation	78 BTU/hr	78 BTU/hr	79 BTU/hr
	Sleep	6 BTU/hr	6 BTU/hr	6 BTU/hr
	Off	2 BTU/hr	3 BTU/hr	2 BTU/hr
TOWER	Normal Operation	88 BTU/hr	97 BTU/hr	89 BTU/hr
	Sleep	6 BTU/hr	6 BTU/hr	6 BTU/hr
	Off	2 BTU/hr	3 BTU/hr	2 BTU/hr

^{*}NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

	oise Emissions nce with ISO 7779 and ISO 9296)	Sound Power (LWAd, bels)	Sound Pressure (LpAm, decibels)
Model	(Typically configured)		
DM	Idle	Pending	Pending
	Fixed Disk (random writes)	Pending	Pending
USDT	Idle	3.6	27
	Fixed Disk (random writes)	3.6	27
SFF	Idle	3.6	26
	Fixed Disk (random writes)	3.6	26
TOWER	Idle	3.6	25
	Fixed Disk (random writes)	3.6	26
Longevity and Upgrading	This product can be upgraded, possibly	extending its useful life by several	years.

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production. This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries

Batteries used in the product do not contain:

- Mercury greater the 1ppm by weight
- Cadmium greater than 20ppm by weight

Battery Size CR2032 (coin cell)
Battery Type Lithium

Model Additional Information

Technical Specifications – Environmental Data

DM

Pending

USDT

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2002/95/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive -2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold where HP registers commercial desktop products. See http://www.epeat.net for registration status in your country.
- Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 12.2% post consumer recycled plastic (by wt.)
- This product is 95.4% recyclable when properly disposed of at end of life.

Packaging Materials

External:

PAPER/Corrugated 1526.2 g

Internal:

PLASTIC/Polyethylene low density
 177 g

- The PAPER/Corrugated material contains at least 49.42% recycled content.
- The PLASTIC/Polyethylene low density material contains at least 60.42% recycled content.

SFF

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2002/95/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive -2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold where HP registers commercial desktop products. See http://www.epeat.net for registration status in your country.
- Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 14.8% post consumer recycled plastic (by wt.)
- This product is 94.1% recyclable when properly disposed of at end of life.

Packaging Materials

External:

PAPER/Corrugated
 2300 g

Internal:

- o PLASTIC/EPE-Expanded Polyethylene 110 g
- PLASTIC/Polyethylene low density
 56 g
- o PLASTIC/Polypropylene 15 g
- The PAPER/Corrugated material contains at least 38.38% recycled content.
- The PLASTIC/EPE-Expanded Polyethylene material contains at least 60.42% recycled content.
- The PLASTIC/Polyethylene low density material contains at least 60.42% recycled content.

Technical Specifications – Environmental Data

TOWER

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2002/95/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive -2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold where HP registers commercial desktop products. See http://www.epeat.net for registration status in your country.
- Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 14.9% post consumer recycled plastic (by wt.)
- This product is 95.5% recyclable when properly disposed of at end of life.

Packaging Materials

- External:
 - PAPER/Corrugated
 2280 g
- Internal:
 - PLASTIC/EPE (Expanded Polystyrene) 144 g
 - PLASTIC/Polyethylene low density 40 g
 - o PLASTIC/Polypropylene 15 g
- The PAPER/Corrugated material contains at least 53.5% recycled content.
- The PLASTIC/EPE (Expanded Polystyrene) material contains at least 60.42% recycled content.
- The PLASTIC/Polyethylene low density material contains at least 60.42% recycled content.
- The PLASTIC/Polypropylene material contains at least 60.42% recycled content.

RoHS Compliance

Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis. By July 1, 2006, RoHS substances will be virtually eliminated (virtually = to levels below legal limits) for all HP electronic products subject to the RoHS Directive, except where it is widely recognized that there is no technically feasible alternative (as indicated by an exemption under the EU RoHS Directive).

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at:

http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):

- Asbestos
- Certain Azo Colorants
- · Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- · Chlorinated Paraffins
- Formaldehyde
- · Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.

Technical Specifications – Environmental Data

- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- **Radioactive Substances**
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

and Recycling

End-of-life Management Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

> The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

Hewlett-Packard Corporate Environmental Information

For more information about HP's commitment to the environment:

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html

ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html

After-Market Options (availability may vary by region)

Communication Devices	DM	USDT	SFF/TWR	Part Number
Intel Ethernet I210 – T1 Gbe NIC			Х	E0X95AA
Intel 6205 802.11 a/b/g/n PCIe x1 NIC			X	E0X93AA
Graphics Solutions	DM	USDT	SFF/TWR	Part Number
AMD Radeon HD 8350 Graphics (PCIe x16)			Х	E1C63AA
AMD Radeon HD 8490 Graphics Card			Х	E1C64AA
Nvidia NVS 310 Graphics (PCIe x16)			Χ	A7U59AA
Nvidia NVS 315 Graphics (PCIe x16)			Χ	E1C65AA
HP USB Graphics Adapter		Χ	Χ	NL571AA
HP DisplayPort Cable Kit	Х	Χ	Χ	VN567AA
HP DisplayPort To Dual Link DVI-D Adapter	Χ	Χ	Χ	NR078AA
HP DisplayPort To DVI-D Adapter	Χ	Χ	Χ	FH973AA
HP DisplayPort to HDMI Adapter	Χ	Χ	Χ	BP937AA
HP DisplayPort to VGA Adapter	Χ	X	Χ	AS615AA
HP DMS-59 to Dual DVI Cable			Χ	DL139A
HP DMS-59 to Dual DisplayPort Adapter			Х	XP688AA
Data Storage Drives and Accessories	DM	USDT	SFF/TWR	Part Number
HP 500-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive			Х	QK554AA
HP 1-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive			Х	QK555AA
HP 1-TB 10K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive			Х	C2T91AA
HP 128-GB SATA 3.0Gb/s Solid State Drive	Х	Х	Х	QV063AA
HP 160-GB SATA 3.0Gb/s Solid State Drive	Х	Χ	Х	QV064AA*
HP 500-GB SATA 3.0Gb/s Solid State Hybrid Drive	Χ	Χ	Χ	E1C62AA
HP 128-GB SED Opal 2 Solid State Drive	Х			G1K24AA
HP Slim Removable SATA Hard Drive Enclosure (frame & carrier)		Χ	Х	C1N41AA
HP Slim Removable SATA Hard Drive Enclosure (carrier only)		Χ	Χ	E3F39AA
HP Chassis (1bay) Security Kit			TWR only	AR639AA
*Not available in all regions.				
Input Devices	DM	USDT	SFF/TWR	Part Number
HP USB Keyboard	Х	Χ	Х	QY776AA
HP USB Gray Keyboard	Х	Χ	Х	B6B64AA
HP USB Smart Card (CCID) Keyboard	Х	Χ	Х	BV813AA
HP USB Keyboard and Mouse Kit	Х	Х	Х	B1T09AA
HP USB Washable Keyboard	Χ	Х	Х	VF097AA
HP USB and PS/2 Washable Mouse	Х	Х	Х	BM866AA
HP USB and PS/2 Washable Keyboard and Mouse Kit	Χ	X	Х	BU207AA

After-Market Options (availability may vary by region)				
HP PS/2 Mouse	Χ	Х	Х	QY775AA
HP USB Mouse	Χ	Χ	Χ	QY777AA
HP USB 1000dpi Laser Mouse	Χ	Χ	Χ	QY778AA
HP Wireless Keyboard and Mouse Combination*	Χ	Χ	Χ	QY449AA
*Keyboard contains 25% post-consumer recycled plastic material				
System Memory	DM	USDT	SFF/TWR	Part Number
HP 4GB DDR3-1600 (PC3-12800) DIMM			Χ	B4U36AA
HP 8GB DDR3-1600 (PC3-12800) DIMM			Χ	B4U37AA
HP 4GB DDR3-1600 (PC3-12800) SODIMM	Χ	Χ		B4U39AA
HP 8GB DDR3-1600 (PC3-12800) SODIMM	Χ	Х		B4U40AA
Multimedia Devices	DM	USDT	SFF/TWR	Part Number
HP Slim DVD-ROM Drive		Χ	Х	VP033AA
HP Slim SuperMulti DVD Writer Drive		Χ	Х	QS209AA
HP USB HD 720P v2 Business Webcam	Χ	Χ	X	D8Z08AA
HP Business Headset	Χ	Χ	Χ	QK550AA
HP USB Business Speakers	Χ	Χ	Х	D9J19AA
Removable Media Storage	DM	USDT	SFF/TWR	Part Number
Removable Media Storage HP 14-n-1 Media Card Reader	DM	USDT	SFF/TWR X	Part Number TBD
_	DM DM	USDT		
HP 14-n-1 Media Card Reader			Х	TBD
HP 14-n-1 Media Card Reader Security Devices		USDT	Х	TBD Part Number
HP 14-n-1 Media Card Reader Security Devices HP USDT Rear Port Controller Cover		USDT X	X SFF/TWR	TBD Part Number VN571AA
HP 14-n-1 Media Card Reader Security Devices HP USDT Rear Port Controller Cover HP Solenoid Lock and Hood Sensor (USDT/SFF) HP Solenoid Lock and Hood Sensor (TWR) HP SFF Wall Mount/Security Sleeve		USDT X	X SFF/TWR SFF only	TBD Part Number VN571AA E0X97AA
HP 14-n-1 Media Card Reader Security Devices HP USDT Rear Port Controller Cover HP Solenoid Lock and Hood Sensor (USDT/SFF) HP Solenoid Lock and Hood Sensor (TWR) HP SFF Wall Mount/Security Sleeve HP UltraSlim Cable Lock	DM X	USDT X	X SFF/TWR SFF only TWR only	TBD Part Number VN571AA E0X97AA E0X96AA VN570AA H4D73AA
HP 14-n-1 Media Card Reader Security Devices HP USDT Rear Port Controller Cover HP Solenoid Lock and Hood Sensor (USDT/SFF) HP Solenoid Lock and Hood Sensor (TWR) HP SFF Wall Mount/Security Sleeve	DM	USDT X X	X SFF/TWR SFF only TWR only SFF only	TBD Part Number VN571AA E0X97AA E0X96AA VN570AA
HP 14-n-1 Media Card Reader Security Devices HP USDT Rear Port Controller Cover HP Solenoid Lock and Hood Sensor (USDT/SFF) HP Solenoid Lock and Hood Sensor (TWR) HP SFF Wall Mount/Security Sleeve HP UltraSlim Cable Lock	DM X	USDT X X	X SFF/TWR SFF only TWR only SFF only	TBD Part Number VN571AA E0X97AA E0X96AA VN570AA H4D73AA
HP 14-n-1 Media Card Reader Security Devices HP USDT Rear Port Controller Cover HP Solenoid Lock and Hood Sensor (USDT/SFF) HP Solenoid Lock and Hood Sensor (TWR) HP SFF Wall Mount/Security Sleeve HP UltraSlim Cable Lock HP DM Security Sleeve	DM X X	USDT X X	X SFF/TWR SFF only TWR only SFF only X	TBD Part Number VN571AA E0X97AA E0X96AA VN570AA H4D73AA G1K22AA
HP 14-n-1 Media Card Reader Security Devices HP USDT Rear Port Controller Cover HP Solenoid Lock and Hood Sensor (USDT/SFF) HP Solenoid Lock and Hood Sensor (TWR) HP SFF Wall Mount/Security Sleeve HP UltraSlim Cable Lock HP DM Security Sleeve Stands and Accessories	DM X X	USDT X X	X SFF/TWR SFF only TWR only SFF only X	TBD Part Number VN571AA E0X97AA E0X96AA VN570AA H4D73AA G1K22AA Part Number
HP 14-n-1 Media Card Reader Security Devices HP USDT Rear Port Controller Cover HP Solenoid Lock and Hood Sensor (USDT/SFF) HP Solenoid Lock and Hood Sensor (TWR) HP SFF Wall Mount/Security Sleeve HP UltraSlim Cable Lock HP DM Security Sleeve Stands and Accessories HP Integrated Work Center Stand (DM)	DM X X	USDT X X	X SFF/TWR SFF only TWR only SFF only X	TBD Part Number VN571AA E0X97AA E0X96AA VN570AA H4D73AA G1K22AA Part Number Pending
HP 14-n-1 Media Card Reader Security Devices HP USDT Rear Port Controller Cover HP Solenoid Lock and Hood Sensor (USDT/SFF) HP Solenoid Lock and Hood Sensor (TWR) HP SFF Wall Mount/Security Sleeve HP UltraSlim Cable Lock HP DM Security Sleeve Stands and Accessories HP Integrated Work Center Stand (DM) HP Integrated Work Center Stand (SFF)	DM X X	USDT X X X	X SFF/TWR SFF only TWR only SFF only X	TBD Part Number VN571AA E0X97AA E0X96AA VN570AA H4D73AA G1K22AA Part Number Pending QP897AA
HP 14-n-1 Media Card Reader Security Devices HP USDT Rear Port Controller Cover HP Solenoid Lock and Hood Sensor (USDT/SFF) HP Solenoid Lock and Hood Sensor (TWR) HP SFF Wall Mount/Security Sleeve HP UltraSlim Cable Lock HP DM Security Sleeve Stands and Accessories HP Integrated Work Center Stand (DM) HP Integrated Work Center Stand (SFF) HP USDT Tower Stand	DM X X	USDT X X X	X SFF/TWR SFF only TWR only SFF only X SFF/TWR SFF only	TBD Part Number VN571AA E0X97AA E0X96AA VN570AA H4D73AA G1K22AA Part Number Pending QP897AA VN568AA
HP 14-n-1 Media Card Reader Security Devices HP USDT Rear Port Controller Cover HP Solenoid Lock and Hood Sensor (USDT/SFF) HP Solenoid Lock and Hood Sensor (TWR) HP SFF Wall Mount/Security Sleeve HP UltraSlim Cable Lock HP DM Security Sleeve Stands and Accessories HP Integrated Work Center Stand (DM) HP Integrated Work Center Stand (SFF) HP USDT Tower Stand HP SFF Tower Stand	DM X X DM X	USDT X X X	X SFF/TWR SFF only TWR only SFF only X SFF/TWR SFF only	TBD Part Number VN571AA E0X97AA E0X96AA VN570AA H4D73AA G1K22AA Part Number Pending QP897AA VN568AA VN569AA
HP 14-n-1 Media Card Reader Security Devices HP USDT Rear Port Controller Cover HP Solenoid Lock and Hood Sensor (USDT/SFF) HP Solenoid Lock and Hood Sensor (TWR) HP SFF Wall Mount/Security Sleeve HP UltraSlim Cable Lock HP DM Security Sleeve Stands and Accessories HP Integrated Work Center Stand (DM) HP Integrated Work Center Stand (SFF) HP USDT Tower Stand HP SFF Tower Stand HP DM Chassis Tower Stand	DM X DM X	USDT X X X	X SFF/TWR SFF only TWR only SFF only X SFF/TWR SFF only	TBD Part Number VN571AA E0X97AA E0X96AA VN570AA H4D73AA G1K22AA Part Number Pending QP897AA VN568AA VN568AA VN569AA G1K23AA
HP 14-n-1 Media Card Reader Security Devices HP USDT Rear Port Controller Cover HP Solenoid Lock and Hood Sensor (USDT/SFF) HP Solenoid Lock and Hood Sensor (TWR) HP SFF Wall Mount/Security Sleeve HP UltraSlim Cable Lock HP DM Security Sleeve Stands and Accessories HP Integrated Work Center Stand (DM) HP Integrated Work Center Stand (SFF) HP USDT Tower Stand HP SFF Tower Stand HP DM Chassis Tower Stand HP DM Rack Mount Shelf	DM X DM X	USDT X X X	X SFF/TWR SFF only TWR only SFF only X SFF/TWR SFF only	TBD Part Number VN571AA E0X97AA E0X96AA VN570AA H4D73AA G1K22AA Part Number Pending QP897AA VN568AA VN569AA G1K23AA G1K21AA

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QuickSpecs

After-Market Options (availability may vary by region)

HP Serial Port Adapter (RS-232 compatible)			Χ	PA716A
HP Parallel Port Kit			X	KD061AA
HP PCI Expansion Kit			TWR only	E1V16AA
Belkin USB to Serial Adapter	Х	Χ		EM449AA

LANDesk Software (E-Delivery)	Part Number
LANDesk Management Suite License - 1-499 Nodes E-Delivery	QY369AAE
LANDesk Management Suite License - 500-999 Nodes E-Delivery	QY370AAE
LANDesk Management Suite License - 1000-1999 Nodes E-Delivery	QY371AAE
LANDesk Management Suite License - 2000-4999 Nodes E-Delivery	QY372AAE
LANDesk Management Suite License - 5000-9999 Nodes E-Delivery	QY373AAE
LANDesk Security Suite License E-Delivery	QY379AAE
LANDesk Management Suite 1 Year Maintenance - 1-499 Nodes E-Delivery	HZ825AAE
LANDesk Management Suite 1 Year Maintenance - 500-999 Nodes E-Delivery	HZ826AAE
LANDesk Management Suite 1 Year Maintenance - 1000-1999 Nodes E-Delivery	HZ827AAE
LANDesk Management Suite 1 Year Maintenance - 2000-4999 Nodes E-Delivery	HZ828AAE
LANDesk Management Suite 1 Year Maintenance - 5000-9999 Nodes E-Delivery	HZ829AAE
LANDesk Security Suite 1 Year Subscription	HZ830AAE
LANDesk Patch Management 1 Year Subscription - 1-499 Nodes E-Delivery	HZ831AAE
LANDesk Patch Management 1 Year Subscription - 500-999 Nodes E-Delivery	HZ832AAE
LANDesk Patch Management 1 Year Subscription - 1000-1999 Nodes E-Delivery	HZ833AAE
LANDesk Patch Management 1 Year Subscription - 2000-4999 Nodes E-Delivery	HZ834AAE
LANDesk Patch Management 1 Year Subscription - 5000-9999 Nodes E-Delivery	HZ835AAE

LANDesk Patch Management 1 Year Subscription - 5000-9999 Nodes E-Delivery

HP EliteDesk 800 G1 Series Business Desktop

QuickSpecs

After-Market Options (availability may vary by region)

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